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(54) **SYSTEMS AND METHODS FOR
TRANSCUTANEOUSLY IMPLANTING
MEDICAL DEVICES**

(56) **References Cited**

U.S. PATENT DOCUMENTS

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3,123,790 A 3/1964 Tyler
3,260,656 A 7/1966 Ross, Jr.
3,581,062 A 5/1971 Aston
3,653,841 A 4/1972 Klein
3,719,564 A 3/1973 Lilly, Jr. et al.
3,776,832 A 12/1973 Oswin et al.
3,837,339 A 9/1974 Aisenberg et al.

(Continued)

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FOREIGN PATENT DOCUMENTS

CA 2291105 12/1998
DE 4401400 7/1995

(Continued)

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OTHER PUBLICATIONS

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(Continued)

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(57) **ABSTRACT**

Systems and methods for transcutaneously implanting medi-
cal devices, such as in vivo analyte sensors, are provided.
The systems and methods involve the use of introducers or
inserters made of shape memory alloy (SMA) materials
which are transitionable from one operative state or con-
figuration to another operative state or configuration,
wherein the transition from state to state enables the trans-
cutaneous implantation and/or transcutaneous explantation
of the medical device.

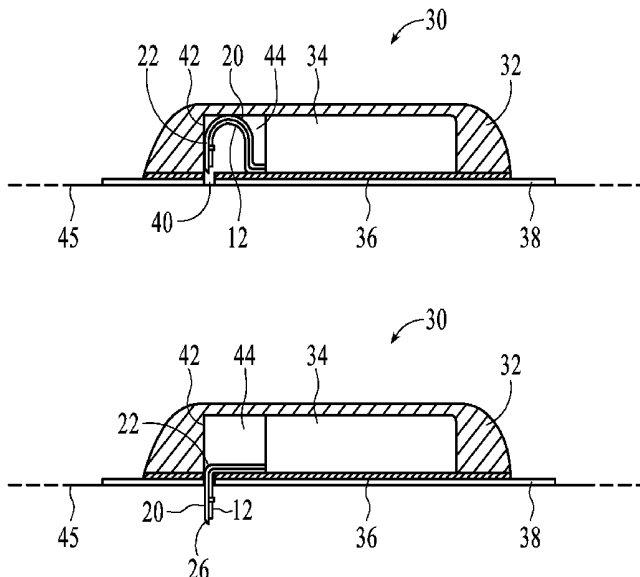
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(58) **Field of Classification Search**

None
See application file for complete search history.

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(56)

References Cited

U.S. PATENT DOCUMENTS

3,926,760 A	12/1975	Allen et al.	4,650,547 A	3/1987	Gough
3,949,388 A	4/1976	Fuller	4,654,197 A	3/1987	Lilja et al.
3,972,320 A	8/1976	Kalman	4,655,880 A	4/1987	Liu
3,979,274 A	9/1976	Newman	4,655,885 A	4/1987	Hill et al.
4,008,717 A	2/1977	Kowarski	4,665,906 A	5/1987	Jervis
4,016,866 A	4/1977	Lawton	4,671,288 A	6/1987	Gough
4,036,749 A	7/1977	Anderson	4,679,562 A	7/1987	Luksha
4,055,175 A	10/1977	Clemens et al.	4,680,268 A	7/1987	Clark, Jr.
4,059,406 A	11/1977	Fleet	4,682,602 A	7/1987	Prohaska
4,076,596 A	2/1978	Connery et al.	4,684,537 A	8/1987	Graetzel et al.
4,098,574 A	7/1978	Dappen	4,685,463 A	8/1987	Williams
4,100,048 A	7/1978	Pompei et al.	4,685,466 A	8/1987	Rau
4,120,292 A	10/1978	LeBlanc, Jr. et al.	4,698,057 A	10/1987	Joishy
4,129,128 A	12/1978	McFarlane	4,703,756 A	11/1987	Gough et al.
4,151,845 A	5/1979	Clemens	4,711,245 A	12/1987	Higgins et al.
4,168,205 A	9/1979	Danniger et al.	4,711,247 A	12/1987	Fishman
4,172,770 A	10/1979	Semersky et al.	4,717,673 A	1/1988	Wrighton et al.
4,178,916 A	12/1979	McNamara	4,721,601 A	1/1988	Wrighton et al.
4,206,755 A	6/1980	Klein	4,721,677 A	1/1988	Clark, Jr.
4,224,125 A	9/1980	Nakamura et al.	4,726,378 A	2/1988	Kaplan
4,240,438 A	12/1980	Updike et al.	4,726,716 A	2/1988	McGuire
4,245,634 A	1/1981	Albisser et al.	4,729,672 A	3/1988	Takagi
4,247,297 A	1/1981	Berti et al.	4,731,726 A	3/1988	Allen, III
4,294,258 A	10/1981	Bernard	4,749,985 A	6/1988	Corsberg
4,327,725 A	5/1982	Cortese et al.	4,755,173 A	7/1988	Konopka
4,340,458 A	7/1982	Lerner et al.	4,757,022 A	7/1988	Shults et al.
4,344,438 A	8/1982	Schultz	4,758,323 A	7/1988	Davis et al.
4,349,728 A	9/1982	Phillips et al.	4,759,371 A	7/1988	Franetzki
4,352,960 A	10/1982	Dormer et al.	4,759,828 A	7/1988	Young et al.
4,356,074 A	10/1982	Johnson	4,764,416 A	8/1988	Ueyama et al.
4,365,637 A	12/1982	Johnson	4,776,944 A	10/1988	Janata et al.
4,366,033 A	12/1982	Richter et al.	4,777,953 A	10/1988	Ash et al.
4,373,527 A	2/1983	Fischell	4,779,618 A	10/1988	Mund et al.
4,375,399 A	3/1983	Havas et al.	4,781,798 A	11/1988	Gough
4,384,586 A	5/1983	Christiansen	4,784,736 A	11/1988	Lonsdale et al.
4,390,621 A	6/1983	Bauer	4,795,707 A	1/1989	Niiyama et al.
4,401,122 A	8/1983	Clark, Jr.	4,796,634 A	1/1989	Huntsman et al.
4,404,066 A	9/1983	Johnson	4,805,624 A	2/1989	Yao et al.
4,418,148 A	11/1983	Oberhardt	4,813,424 A	3/1989	Wilkins
4,425,920 A	1/1984	Bourland et al.	4,815,469 A	3/1989	Cohen et al.
4,427,770 A	1/1984	Chen et al.	4,820,399 A	4/1989	Senda et al.
4,431,004 A	2/1984	Bessman et al.	4,822,337 A	4/1989	Newhouse et al.
4,436,094 A	3/1984	Cerami	4,830,959 A	5/1989	McNeil et al.
4,440,175 A	4/1984	Wilkins	4,832,797 A	5/1989	Vadgama et al.
4,450,842 A	5/1984	Zick et al.	RE32,947 E	6/1989	Dormer et al.
4,458,686 A	7/1984	Clark, Jr.	4,840,893 A	6/1989	Hill et al.
4,461,691 A	7/1984	Frank	4,848,351 A	7/1989	Finch
4,469,110 A	9/1984	Slama	4,854,322 A	8/1989	Ash et al.
4,477,314 A	10/1984	Richter et al.	4,871,351 A	10/1989	Feingold
4,478,976 A	10/1984	Goertz et al.	4,871,440 A	10/1989	Nagata et al.
4,484,987 A	11/1984	Gough	4,874,500 A	10/1989	Madou et al.
4,494,950 A	1/1985	Fischell	4,890,620 A	1/1990	Gough
4,509,531 A	4/1985	Ward	4,894,137 A	1/1990	Takizawa et al.
4,522,690 A	6/1985	Venkatsetty	4,895,147 A	1/1990	Bodicky et al.
4,524,114 A	6/1985	Samuels et al.	4,897,162 A	1/1990	Lewandowski et al.
4,526,661 A	7/1985	Steckhan et al.	4,897,173 A	1/1990	Nankai et al.
4,527,240 A	7/1985	Kvitash	4,909,908 A	3/1990	Ross et al.
4,534,356 A	8/1985	Papadakis	4,911,794 A	3/1990	Parce et al.
4,538,616 A	9/1985	Rogoff	4,917,800 A	4/1990	Lonsdale et al.
4,543,955 A	10/1985	Schroepfel	4,919,141 A	4/1990	Zier et al.
4,545,382 A	10/1985	Higgins et al.	4,919,767 A	4/1990	Vadgama et al.
4,552,840 A	11/1985	Riffer	4,921,199 A	5/1990	Villaveces
4,560,534 A	12/1985	Kung et al.	4,923,586 A	5/1990	Katayama et al.
4,571,292 A	2/1986	Liu et al.	4,925,268 A	5/1990	Iyer et al.
4,573,994 A	3/1986	Fischell et al.	4,927,516 A	5/1990	Yamaguchi et al.
4,581,336 A	4/1986	Malloy et al.	4,934,369 A	6/1990	Maxwell
4,595,011 A	6/1986	Phillips	4,935,105 A	6/1990	Churchouse
4,619,754 A	10/1986	Niki et al.	4,935,345 A	6/1990	Guibeau et al.
4,619,793 A	10/1986	Lee	4,938,860 A	7/1990	Wogoman
4,622,966 A *	11/1986	Beard 606/28	4,944,299 A	7/1990	Silvian
4,627,445 A	12/1986	Garcia et al.	4,950,378 A	8/1990	Nagara
4,627,842 A	12/1986	Katz	4,953,552 A	9/1990	DeMarzo
4,627,908 A	12/1986	Müller	4,954,129 A	9/1990	Giuliani et al.
4,633,878 A	1/1987	Bombardien	4,969,468 A	11/1990	Byers et al.
4,637,403 A	1/1987	Garcia et al.	4,970,145 A	11/1990	Bennetto et al.
			4,974,929 A	12/1990	Curry
			4,986,271 A	1/1991	Wilkins
			4,988,341 A	1/1991	Columbus et al.
			4,994,167 A	2/1991	Shults et al.

(56)

References Cited

U.S. PATENT DOCUMENTS

4,995,402 A	2/1991	Smith et al.	5,378,628 A	1/1995	Gratzel et al.
5,000,180 A	3/1991	Kuypers et al.	5,379,238 A	1/1995	Stark
5,002,054 A	3/1991	Ash et al.	5,387,327 A	2/1995	Khan
5,013,161 A	5/1991	Zaragoza et al.	5,390,671 A	2/1995	Lord et al.
5,019,974 A	5/1991	Beckers	5,391,250 A	2/1995	Cheney, II et al.
5,035,860 A	7/1991	Kleingeld et al.	5,395,504 A	3/1995	Saurer et al.
5,036,860 A	8/1991	Leigh et al.	5,400,782 A	3/1995	Beaubiah
5,047,044 A	9/1991	Smith et al.	5,408,999 A	4/1995	Singh et al.
5,050,612 A	9/1991	Matsumura	5,411,647 A	5/1995	Johnson et al.
5,055,171 A	10/1991	Peck	5,425,361 A	6/1995	Fenzlein et al.
5,058,592 A	10/1991	Whisler	5,431,160 A	7/1995	Wilkins
5,067,957 A	11/1991	Jervis	5,431,921 A	7/1995	Thombre
5,070,535 A	12/1991	Hochmair et al.	5,437,999 A	8/1995	Diebold et al.
5,082,550 A	1/1992	Rishpon et al.	5,462,645 A	10/1995	Albery et al.
5,082,786 A	1/1992	Nakamoto	5,469,846 A	11/1995	Khan
5,089,112 A	2/1992	Skotheim et al.	5,472,317 A	12/1995	Field et al.
5,095,904 A	3/1992	Seligman et al.	5,489,414 A	2/1996	Schreiber et al.
5,101,814 A	4/1992	Palti	5,491,474 A	2/1996	Suni et al.
5,106,365 A	4/1992	Hernandez	5,494,562 A	2/1996	Maley et al.
5,108,564 A	4/1992	Szuminsky et al.	5,496,453 A	3/1996	Uenoyama et al.
5,108,889 A	4/1992	Smith et al.	5,497,772 A	3/1996	Schulman et al.
5,109,850 A	5/1992	Blanco et al.	5,507,288 A	4/1996	Bocker et al.
5,120,420 A	6/1992	Nankai et al.	5,509,410 A	4/1996	Hill et al.
5,122,925 A	6/1992	Inpyn	5,514,718 A	5/1996	Lewis et al.
5,126,034 A	6/1992	Carter et al.	5,531,878 A	7/1996	Vadgama et al.
5,133,856 A	7/1992	Yamaguchi et al.	5,533,977 A	7/1996	Matcalf et al.
5,135,003 A	8/1992	Souma	5,545,191 A	8/1996	Mann et al.
5,140,985 A	8/1992	Schroeder et al.	5,551,427 A	9/1996	Altman
5,141,868 A	8/1992	Shanks et al.	5,560,357 A	10/1996	Faupei et al.
5,161,532 A	11/1992	Joseph	5,562,713 A	10/1996	Silvian
5,165,407 A	11/1992	Wilson et al.	5,565,085 A	10/1996	Ikeda et al.
5,174,291 A	12/1992	Schoonen et al.	5,567,302 A	10/1996	Song et al.
5,190,041 A	3/1993	Palti	5,568,806 A	10/1996	Cheney, II et al.
5,190,546 A	3/1993	Jervis	5,569,186 A	10/1996	Lord et al.
5,192,416 A	3/1993	Wang et al.	5,575,563 A	11/1996	Chiu et al.
5,198,367 A	3/1993	Aizawa et al.	5,582,184 A	12/1996	Erickson et al.
5,202,261 A	4/1993	Musho et al.	5,582,697 A	12/1996	Ikeda et al.
5,205,920 A	4/1993	Oyama et al.	5,582,698 A	12/1996	Flaherty et al.
5,208,154 A	5/1993	Weaver et al.	5,584,813 A	12/1996	Livingston et al.
5,209,229 A	5/1993	Gilli	5,586,553 A	12/1996	Halili et al.
5,217,595 A	6/1993	Smith et al.	5,589,326 A	12/1996	Deng et al.
5,229,282 A	7/1993	Yoshioka et al.	5,593,852 A	1/1997	Heller et al.
5,234,835 A	8/1993	Nestor et al.	5,596,150 A	1/1997	Arndt et al.
5,238,729 A	8/1993	Debe	5,597,378 A	1/1997	Jervis
5,246,867 A	9/1993	Lakowicz et al.	5,601,435 A	2/1997	Quy
5,250,439 A	10/1993	Musho et al.	5,609,575 A	3/1997	Larson et al.
5,262,035 A	11/1993	Gregg et al.	5,617,851 A	4/1997	Lipkovker
5,262,305 A	11/1993	Heller et al.	5,628,310 A	5/1997	Rao et al.
5,264,103 A	11/1993	Yoshioka et al.	5,628,890 A	5/1997	Carter et al.
5,264,104 A	11/1993	Gregg et al.	5,632,557 A	5/1997	Simons
5,264,105 A	11/1993	Gregg et al.	5,651,869 A	7/1997	Yoshioka et al.
5,264,106 A	11/1993	McAleer et al.	5,653,239 A	8/1997	Pompei et al.
5,271,815 A	12/1993	Wong	5,660,163 A	8/1997	Schulman et al.
5,279,294 A	1/1994	Anderson et al.	5,665,222 A	9/1997	Heller et al.
5,284,156 A	2/1994	Schramm et al.	5,670,031 A	9/1997	Hintsche et al.
5,285,792 A	2/1994	Sjoquist et al.	5,680,858 A	10/1997	Hansen et al.
5,286,362 A	2/1994	Hoenes et al.	5,682,233 A	10/1997	Brinda
5,286,364 A	2/1994	Yacynych et al.	5,695,623 A	12/1997	Michel et al.
5,288,636 A	2/1994	Pollmann et al.	5,708,247 A	1/1998	McAleer et al.
5,293,546 A	3/1994	Tadros et al.	5,711,001 A	1/1998	Bussan et al.
5,293,877 A	3/1994	O'Hara et al.	5,711,297 A	1/1998	Iliff et al.
5,299,571 A	4/1994	Mastrototaro	5,711,861 A	1/1998	Ward et al.
5,320,098 A	6/1994	Davidson	5,711,862 A	1/1998	Sakoda et al.
5,320,725 A	6/1994	Gregg et al.	5,733,044 A	3/1998	Rose et al.
5,322,063 A	6/1994	Allen et al.	5,735,285 A	4/1998	Albert et al.
5,337,747 A	8/1994	Neftei	5,741,211 A	4/1998	Renirie et al.
5,340,722 A	8/1994	Wolfbeis et al.	5,749,656 A	5/1998	Boehm et al.
5,342,789 A	8/1994	Chick et al.	5,766,131 A	6/1998	Kondo et al.
5,352,348 A	10/1994	Young et al.	5,771,001 A	6/1998	Cobb
5,356,786 A	10/1994	Heller et al.	5,772,586 A	6/1998	Heinonen et al.
5,360,404 A	11/1994	Novacek et al.	5,779,665 A	7/1998	Mastrototaro et al.
5,368,028 A	11/1994	Palti	5,791,344 A	8/1998	Schulman et al.
5,372,133 A	12/1994	Hogen Esch	5,800,420 A	9/1998	Gross et al.
5,372,427 A	12/1994	Padovani et al.	5,807,375 A	9/1998	Gross et al.
5,376,251 A	12/1994	Kaneko et al.	5,820,551 A	10/1998	Hill et al.
			5,820,622 A	10/1998	Gross et al.
			5,822,715 A	10/1998	Worthington et al.
			5,827,184 A	10/1998	Netherly et al.
			5,840,020 A	11/1998	Heinonen et al.

(56)

References Cited

U.S. PATENT DOCUMENTS

5,842,983	A	12/1998	Abel et al.	6,437,679	B1	8/2002	Roques
5,851,197	A	12/1998	Marano et al.	6,440,068	B1	8/2002	Brown et al.
5,865,804	A	2/1999	Bachynsky	6,451,025	B1	9/2002	Jervis
5,885,211	A	3/1999	Eppstein et al.	6,478,736	B1	11/2002	Mault
5,899,855	A	5/1999	Brown	6,484,045	B1	11/2002	Holker et al.
5,924,979	A	7/1999	Sedlow et al.	6,484,046	B1	11/2002	Say et al.
5,925,021	A	7/1999	Castellano et al.	6,514,718	B2	2/2003	Heller et al.
5,948,006	A	9/1999	Mann	6,520,326	B2	2/2003	McIvor et al.
5,951,521	A	9/1999	Mastrototaro et al.	6,522,927	B1	2/2003	Bishay et al.
5,954,643	A	9/1999	Van Antwerp	6,533,805	B1	3/2003	Jervis
5,954,685	A	9/1999	Tierny	6,551,494	B1	4/2003	Feldman et al.
5,957,854	A	9/1999	Besson et al.	6,551,496	B1	4/2003	Moles et al.
5,961,451	A	10/1999	Reber et al.	6,558,320	B1	5/2003	Causey, III et al.
5,964,993	A	10/1999	Blubaugh, Jr. et al.	6,558,321	B1	5/2003	Burd et al.
5,965,380	A	10/1999	Heller et al.	6,560,471	B1	5/2003	Heller et al.
5,971,922	A	10/1999	Arita et al.	6,561,978	B1	5/2003	Conn et al.
5,972,199	A	10/1999	Heller et al.	6,562,001	B2	5/2003	Lebel et al.
5,987,353	A	11/1999	Khatchatrian et al.	6,564,105	B2	5/2003	Starkweather et al.
5,995,860	A	11/1999	Sun et al.	6,565,509	B1	5/2003	Say et al.
6,001,067	A	12/1999	Shults et al.	6,571,128	B2	5/2003	Lebel et al.
6,004,278	A	12/1999	Botich et al.	6,572,566	B2	6/2003	Effenhauser
6,022,368	A	2/2000	Gavrinsky et al.	6,576,101	B1	6/2003	Heller et al.
6,024,699	A	2/2000	Surwit et al.	6,577,899	B2	6/2003	Lebel et al.
6,026,321	A	2/2000	Miyata et al.	6,579,690	B1	6/2003	Bonnecaze et al.
6,027,459	A	2/2000	Shain et al.	6,585,644	B2	7/2003	Lebel et al.
6,049,727	A	4/2000	Crothall	6,589,229	B1	7/2003	Connelly et al.
6,068,399	A	5/2000	Tseng	6,591,125	B1	7/2003	Buse et al.
6,083,710	A	7/2000	Heller et al.	6,595,919	B2	7/2003	Berner et al.
6,088,608	A	7/2000	Schulman et al.	6,605,200	B1	8/2003	Mao et al.
6,091,975	A	7/2000	Daddona et al.	6,605,201	B1	8/2003	Mao et al.
6,091,976	A	7/2000	Pfeiffer et al.	6,607,509	B2	8/2003	Bobroff et al.
6,093,172	A	7/2000	Funderburk et al.	6,610,012	B2	8/2003	Mault
6,103,033	A	8/2000	Say et al.	6,633,772	B2	10/2003	Ford et al.
6,117,290	A	9/2000	Say et al.	6,635,014	B2	10/2003	Starkweather et al.
6,119,028	A	9/2000	Schulman et al.	6,648,821	B2	11/2003	Lebel et al.
6,120,676	A	9/2000	Heller et al.	6,654,625	B1	11/2003	Say et al.
6,121,009	A	9/2000	Heller et al.	6,659,948	B2	12/2003	Lebel et al.
6,121,611	A	9/2000	Lindsay et al.	6,668,196	B1	12/2003	Villegas et al.
6,122,351	A	9/2000	Schlueter, Jr. et al.	6,676,290	B1	1/2004	Lu
6,134,461	A	10/2000	Say et al.	6,682,546	B2	1/2004	Amplatz
6,143,164	A	11/2000	Heller et al.	6,687,546	B2	2/2004	Lebel et al.
6,159,147	A	12/2000	Lichter et al.	6,689,056	B1	2/2004	Kilcoyne et al.
6,162,611	A	12/2000	Heller et al.	6,694,191	B2	2/2004	Starkweather et al.
6,175,752	B1	1/2001	Say et al.	6,695,860	B1	2/2004	Ward et al.
6,200,265	B1	3/2001	Walsh et al.	6,702,857	B2	3/2004	Brauker et al.
6,212,416	B1	4/2001	Ward et al.	6,733,446	B2	5/2004	Lebel et al.
6,219,574	B1	4/2001	Cormier et al.	6,740,075	B2	5/2004	Lebel et al.
6,248,067	B1	6/2001	Causey, III et al.	6,741,877	B1	5/2004	Shults et al.
6,254,536	B1	7/2001	DeVito	6,746,582	B2	6/2004	Heller et al.
6,254,586	B1	7/2001	Mann et al.	6,758,810	B2	7/2004	Lebel et al.
6,275,717	B1	8/2001	Gross et al.	6,770,030	B1	8/2004	Schaupp et al.
6,283,761	B1	9/2001	Joao	6,790,178	B1	9/2004	Mault et al.
6,283,982	B1	9/2001	Levaughn et al.	6,809,653	B1	10/2004	Mann et al.
6,284,478	B1	9/2001	Heller et al.	6,810,290	B2	10/2004	Lebel et al.
6,293,925	B1	9/2001	Safabash et al.	6,811,533	B2	11/2004	Lebel et al.
6,295,506	B1	9/2001	Heinonen et al.	6,811,534	B2	11/2004	Bowman, IV et al.
6,302,866	B1	10/2001	Marggi	6,813,519	B2	11/2004	Lebel et al.
6,306,104	B1	10/2001	Cunningham et al.	6,837,858	B2	1/2005	Cunningham et al.
6,306,141	B1	10/2001	Jervis	6,849,052	B2	2/2005	Uchigaki et al.
6,309,884	B1	10/2001	Cooper et al.	6,854,882	B2	2/2005	Chen
6,329,161	B1	12/2001	Heller et al.	6,862,465	B2	3/2005	Shults et al.
6,338,790	B1	1/2002	Feldman et al.	6,873,268	B2	3/2005	Lebel et al.
6,348,640	B1	2/2002	Navot et al.	6,881,551	B2	4/2005	Heller et al.
6,359,444	B1	3/2002	Grimes	6,892,085	B2	5/2005	McIvor et al.
6,360,888	B1	3/2002	McIvor et al.	6,895,265	B2	5/2005	Silver
6,366,794	B1	4/2002	Moussy et al.	6,931,327	B2	8/2005	Goode, Jr. et al.
6,368,141	B1	4/2002	Van Antwerp et al.	6,932,894	B2	8/2005	Mao et al.
6,368,274	B1	4/2002	Van Antwerp et al.	6,936,006	B2	8/2005	Sabra
6,368,339	B1	4/2002	Amplatz	6,942,518	B2	9/2005	Liamos et al.
6,377,828	B1	4/2002	Chaiken et al.	6,950,708	B2	9/2005	Bowman, IV et al.
6,379,301	B1	4/2002	Worthington et al.	6,958,705	B2	10/2005	Lebel et al.
6,409,740	B1	6/2002	Kuhr et al.	6,959,211	B2	10/2005	Rule et al.
6,418,332	B1	7/2002	Mastrototaro et al.	6,968,294	B2	11/2005	Gutta et al.
6,424,847	B1	7/2002	Mastrototaro et al.	6,971,274	B2	12/2005	Olin
6,427,088	B1	7/2002	Bowman, IV et al.	6,974,437	B2	12/2005	Lebel et al.
				6,990,366	B2	1/2006	Say et al.
				6,997,907	B2	2/2006	Safabash et al.
				6,998,247	B2	2/2006	Monfre et al.
				7,003,336	B2	2/2006	Holker et al.

(56)

References Cited

U.S. PATENT DOCUMENTS

7,003,340 B2	2/2006	Say et al.	2002/0019022 A1	2/2002	Dunn et al.
7,003,341 B2	2/2006	Say et al.	2002/0022855 A1	2/2002	Bobroff et al.
7,024,245 B2	4/2006	Lebel et al.	2002/0023852 A1	2/2002	McIvor et al.
7,025,743 B2	4/2006	Mann et al.	2002/0042090 A1	4/2002	Heller et al.
7,041,068 B2	5/2006	Freeman et al.	2002/0082487 A1	6/2002	Kollias et al.
7,041,468 B2	5/2006	Drucker et al.	2002/0103499 A1	8/2002	Perez et al.
7,052,483 B2	5/2006	Wojcik	2002/0106709 A1	8/2002	Potts et al.
7,056,302 B2	6/2006	Douglas	2002/0119711 A1	8/2002	VanAntwerp et al.
7,074,307 B2	7/2006	Simpson et al.	2002/0128594 A1	9/2002	Das et al.
7,081,195 B2	7/2006	Simpson et al.	2002/0130042 A1	9/2002	Moerman et al.
7,097,637 B2	8/2006	Triplett et al.	2002/0154050 A1	10/2002	Krupp et al.
7,098,803 B2	8/2006	Mann et al.	2002/0161288 A1	10/2002	Shin et al.
7,108,778 B2	9/2006	Simpson et al.	2002/0165462 A1	11/2002	Westbrook et al.
7,110,803 B2	9/2006	Shults et al.	2002/0198444 A1	12/2002	Uchigaki et al.
7,113,821 B1	9/2006	Sun et al.	2002/0198543 A1*	12/2002	Burdulis et al. 606/144
7,134,999 B2	11/2006	Brauker et al.	2003/0023317 A1	1/2003	Brauker et al.
7,136,689 B2	11/2006	Shults et al.	2003/0023461 A1	1/2003	Quintanilla et al.
7,171,274 B2	1/2007	Starkweather et al.	2003/0032867 A1	2/2003	Crothall et al.
7,190,988 B2	3/2007	Say et al.	2003/0032874 A1	2/2003	Rhodes et al.
7,192,450 B2	3/2007	Brauker et al.	2003/0042137 A1	3/2003	Mao et al.
7,198,606 B2	4/2007	Boecker et al.	2003/0060753 A1	3/2003	Starkweather et al.
7,207,974 B2	4/2007	Safabash et al.	2003/0065308 A1	4/2003	Lebel et al.
7,226,978 B2	6/2007	Tapsak et al.	2003/0069510 A1	4/2003	Semler
7,276,029 B2	10/2007	Goode, Jr. et al.	2003/0078481 A1	4/2003	McIvor et al.
7,278,983 B2	10/2007	Ireland et al.	2003/0078560 A1	4/2003	Miller et al.
7,297,151 B2	11/2007	Boecker et al.	2003/0097092 A1	5/2003	Flaherty
7,299,082 B2	11/2007	Feldman et al.	2003/0100040 A1	5/2003	Bonnecaze et al.
7,310,544 B2	12/2007	Brister et al.	2003/0109775 A1	6/2003	O'Neil et al.
7,318,816 B2	1/2008	Bobroff et al.	2003/0134347 A1	7/2003	Heller et al.
7,324,012 B2	1/2008	Mann et al.	2003/0135333 A1	7/2003	Aceti et al.
7,329,239 B2	2/2008	Safabash et al.	2003/0144581 A1	7/2003	Conn et al.
7,335,294 B2	2/2008	Heller et al.	2003/0144608 A1	7/2003	Kojima et al.
7,340,309 B2	3/2008	Miazga et al.	2003/0155656 A1	8/2003	Chiu et al.
7,354,420 B2	4/2008	Steil et al.	2003/0168338 A1	9/2003	Gao et al.
7,364,592 B2	4/2008	Carr-Brendel et al.	2003/0176933 A1	9/2003	Lebel et al.
7,366,556 B2	4/2008	Brister et al.	2003/0187338 A1	10/2003	Say et al.
7,379,765 B2	5/2008	Petisce et al.	2003/0199790 A1	10/2003	Boecker et al.
7,381,184 B2	6/2008	Funderburk et al.	2003/0199910 A1	10/2003	Boecker et al.
7,402,153 B2	7/2008	Steil et al.	2003/0212379 A1	11/2003	Bylund et al.
7,416,541 B2	8/2008	Yuzhakov et al.	2003/0217966 A1	11/2003	Tapsak et al.
7,424,318 B2	9/2008	Brister et al.	2003/0225361 A1	12/2003	Sabra
7,455,663 B2	11/2008	Bikovskiy	2004/0002682 A1	1/2004	Kovelman et al.
7,460,898 B2	12/2008	Brister et al.	2004/0010207 A1	1/2004	Flaherty et al.
7,462,264 B2	12/2008	Heller et al.	2004/0011671 A1	1/2004	Shults et al.
7,467,003 B2	12/2008	Brister et al.	2004/0040840 A1	3/2004	Mao et al.
7,471,972 B2	12/2008	Rhodes et al.	2004/0045879 A1	3/2004	Shults et al.
7,494,465 B2	2/2009	Brister et al.	2004/0054263 A1	3/2004	Moerman et al.
7,497,827 B2	3/2009	Brister et al.	2004/0064068 A1	4/2004	DeNuzzio et al.
7,499,002 B2	3/2009	Blasko et al.	2004/0064133 A1	4/2004	Miller et al.
7,519,408 B2	4/2009	Rasdal et al.	2004/0096959 A1	5/2004	Stiene et al.
7,583,990 B2	9/2009	Goode, Jr. et al.	2004/0106858 A1	6/2004	Say et al.
7,591,801 B2	9/2009	Brauker et al.	2004/0106859 A1	6/2004	Say et al.
7,599,726 B2	10/2009	Goode, Jr. et al.	2004/0116866 A1	6/2004	Gorman et al.
7,613,491 B2	11/2009	Boock et al.	2004/0122353 A1	6/2004	Shahmirian et al.
7,615,007 B2	11/2009	Shults et al.	2004/0122489 A1	6/2004	Mazar et al.
7,632,228 B2	12/2009	Brauker et al.	2004/0133164 A1	7/2004	Funderburk et al.
7,637,868 B2	12/2009	Saint et al.	2004/0135684 A1	7/2004	Steinthal et al.
7,640,048 B2	12/2009	Dobbles et al.	2004/0138588 A1	7/2004	Saikley et al.
7,651,596 B2	1/2010	Petisce et al.	2004/0147996 A1	7/2004	Miazga et al.
7,654,956 B2	2/2010	Brister et al.	2004/0152622 A1	8/2004	Keith et al.
7,657,297 B2	2/2010	Simpson et al.	2004/0158207 A1	8/2004	Hunn et al.
7,666,149 B2	2/2010	Simons et al.	2004/0167801 A1	8/2004	Say et al.
7,697,967 B2	4/2010	Stafford	2004/0171921 A1	9/2004	Say et al.
7,711,402 B2	5/2010	Shults et al.	2004/0176672 A1	9/2004	Silver et al.
7,713,574 B2	5/2010	Brister et al.	2004/0186362 A1	9/2004	Brauker et al.
7,715,893 B2	5/2010	Kamath et al.	2004/0186365 A1	9/2004	Jin et al.
7,727,147 B1	6/2010	Osorio et al.	2004/0193090 A1	9/2004	Lebel et al.
7,731,657 B2	6/2010	Stafford	2004/0199059 A1	10/2004	Brauker et al.
7,736,344 B2	6/2010	Moberg et al.	2004/0204687 A1	10/2004	Mogensen et al.
7,763,042 B2	7/2010	Iio et al.	2004/0225338 A1	11/2004	Lebel et al.
7,822,454 B1	10/2010	Alden et al.	2004/0236200 A1	11/2004	Say et al.
7,842,046 B1*	11/2010	Nakao A61B 17/0469 606/144	2004/0236251 A1	11/2004	Roe et al.
			2004/0254433 A1	12/2004	Bandis et al.
			2004/0254434 A1	12/2004	Goodnow et al.
			2004/0267300 A1	12/2004	Mace
			2005/0003470 A1	1/2005	Nelson et al.
			2005/0004494 A1	1/2005	Perez et al.
			2005/0010269 A1	1/2005	Lebel et al.
			2005/0027177 A1	2/2005	Shin et al.
7,985,222 B2	7/2011	Gall et al.			
2002/0013538 A1	1/2002	Teller			

(56)

References Cited

U.S. PATENT DOCUMENTS

2005/0027180	A1	2/2005	Goode, Jr. et al.	2007/0078320	A1	4/2007	Stafford
2005/0031689	A1	2/2005	Shults et al.	2007/0078321	A1	4/2007	Mazza et al.
2005/0043598	A1	2/2005	Goode, Jr. et al.	2007/0078322	A1	4/2007	Stafford
2005/0070819	A1	3/2005	Poux et al.	2007/0095661	A1	5/2007	Wang et al.
2005/0085872	A1	4/2005	Yanagihara et al.	2007/0106135	A1	5/2007	Sloan et al.
2005/0090607	A1	4/2005	Tapsak et al.	2007/0110124	A1	5/2007	Shiraki et al.
2005/0090850	A1	4/2005	Thoes et al.	2007/0123819	A1	5/2007	Mernoe et al.
2005/0106713	A1	5/2005	Phan et al.	2007/0149875	A1	6/2007	Ouyang et al.
2005/0112169	A1	5/2005	Brauker et al.	2007/0163880	A1	7/2007	Woo et al.
2005/0114068	A1	5/2005	Chey et al.	2007/0173706	A1	7/2007	Neinast et al.
2005/0121322	A1	6/2005	Say et al.	2007/0173741	A1	7/2007	Deshmukh et al.
2005/0131346	A1	6/2005	Douglas	2007/0191701	A1	8/2007	Feldman et al.
2005/0143635	A1	6/2005	Kamath et al.	2007/0203407	A1	8/2007	Hoss et al.
2005/0149066	A1*	7/2005	Stafford 606/144	2007/0203966	A1	8/2007	Brauker et al.
2005/0154410	A1	7/2005	Conway et al.	2007/0235331	A1	10/2007	Simpson et al.
2005/0165404	A1	7/2005	Miller	2007/0244368	A1	10/2007	Bayloff et al.
2005/0176136	A1	8/2005	Burd et al.	2007/0244379	A1	10/2007	Boock et al.
2005/0182306	A1	8/2005	Sloan	2007/0244398	A1	10/2007	Lo et al.
2005/0187720	A1	8/2005	Goode, Jr. et al.	2007/0249922	A1	10/2007	Peysner et al.
2005/0192557	A1	9/2005	Brauker et al.	2007/0255302	A1	11/2007	Koeppel et al.
2005/0195930	A1	9/2005	Spital et al.	2008/0004512	A1	1/2008	Funderburk et al.
2005/0197554	A1	9/2005	Polcha	2008/0004573	A1	1/2008	Kaufmann et al.
2005/0199494	A1	9/2005	Say et al.	2008/0009692	A1	1/2008	Stafford
2005/0203360	A1	9/2005	Brauker et al.	2008/0009805	A1	1/2008	Ethelfeld
2005/0222518	A1	10/2005	Dib	2008/0017522	A1	1/2008	Heller et al.
2005/0239154	A1	10/2005	Feldman et al.	2008/0021543	A1*	1/2008	Shrivastava 623/1.31
2005/0239156	A1	10/2005	Drucker et al.	2008/0021666	A1	1/2008	Goode, Jr. et al.
2005/0241957	A1	11/2005	Mao et al.	2008/0027474	A1	1/2008	Curry et al.
2005/0245795	A1	11/2005	Goode, Jr. et al.	2008/0029391	A1	2/2008	Mao et al.
2005/0245799	A1	11/2005	Brauker et al.	2008/0033254	A1	2/2008	Kamath et al.
2005/0245844	A1	11/2005	Mace et al.	2008/0033268	A1	2/2008	Stafford
2005/0267327	A1	12/2005	Iizuka et al.	2008/0033318	A1	2/2008	Mace et al.
2005/0277164	A1	12/2005	Drucker et al.	2008/0039702	A1	2/2008	Hayter et al.
2005/0287620	A1	12/2005	Heller et al.	2008/0045824	A1	2/2008	Tapsak et al.
2006/0001538	A1	1/2006	Kraft et al.	2008/0064937	A1	3/2008	McGarraugh et al.
2006/0004303	A1	1/2006	Weidenhaupt et al.	2008/0064941	A1	3/2008	Funderburk et al.
2006/0010098	A1	1/2006	Goodnow et al.	2008/0065646	A1	3/2008	Zhang et al.
2006/0015020	A1	1/2006	Neale et al.	2008/0071156	A1	3/2008	Brister et al.
2006/0015024	A1	1/2006	Brister et al.	2008/0083617	A1	4/2008	Simpson et al.
2006/0016700	A1	1/2006	Brister et al.	2008/0086042	A1	4/2008	Brister et al.
2006/0019327	A1	1/2006	Brister et al.	2008/0086044	A1	4/2008	Brister et al.
2006/0020186	A1	1/2006	Brister et al.	2008/0086273	A1	4/2008	Shults et al.
2006/0020187	A1	1/2006	Brister et al.	2008/0097246	A1	4/2008	Stafford
2006/0020188	A1	1/2006	Kamath et al.	2008/0108942	A1	5/2008	Brister et al.
2006/0020189	A1	1/2006	Brister et al.	2008/0112848	A1	5/2008	Huffstodt et al.
2006/0020190	A1	1/2006	Kamath et al.	2008/0114280	A1	5/2008	Stafford
2006/0020191	A1	1/2006	Brister et al.	2008/0119707	A1	5/2008	Stafford
2006/0020192	A1	1/2006	Brister et al.	2008/0133702	A1	6/2008	Sharma et al.
2006/0036139	A1	2/2006	Brister et al.	2008/0154286	A1	6/2008	Abbott et al.
2006/0036140	A1	2/2006	Brister et al.	2008/0167578	A1	7/2008	Bryer et al.
2006/0036141	A1	2/2006	Kamath et al.	2008/0183061	A1	7/2008	Goode, Jr. et al.
2006/0036142	A1	2/2006	Brister et al.	2008/0183399	A1	7/2008	Goode, Jr. et al.
2006/0036143	A1	2/2006	Brister et al.	2008/0188731	A1	8/2008	Brister et al.
2006/0036144	A1	2/2006	Brister et al.	2008/0189051	A1	8/2008	Goode, Jr. et al.
2006/0036145	A1	2/2006	Brister et al.	2008/0194935	A1	8/2008	Brister et al.
2006/0129173	A1	6/2006	Wilkinson	2008/0194936	A1	8/2008	Goode, Jr. et al.
2006/0155210	A1	7/2006	Beckman et al.	2008/0194937	A1	8/2008	Goode, Jr. et al.
2006/0155317	A1	7/2006	List et al.	2008/0194938	A1	8/2008	Brister et al.
2006/0166629	A1	7/2006	Reggiardo	2008/0195232	A1	8/2008	Carr-Brendel et al.
2006/0173444	A1	8/2006	Choy et al.	2008/0195967	A1	8/2008	Goode, Jr. et al.
2006/0189863	A1	8/2006	Peysner et al.	2008/0197024	A1	8/2008	Simpson et al.
2006/0189939	A1	8/2006	Gonnelli et al.	2008/0200788	A1	8/2008	Brister et al.
2006/0195029	A1	8/2006	Shults et al.	2008/0200789	A1	8/2008	Brister et al.
2006/0200970	A1	9/2006	Brister et al.	2008/0200791	A1	8/2008	Simpson et al.
2006/0222566	A1	10/2006	Brauker et al.	2008/0200897	A1	8/2008	Hoss et al.
2006/0226985	A1	10/2006	Goodnow et al.	2008/0208025	A1	8/2008	Shults et al.
2006/0247508	A1	11/2006	Fennell	2008/0214915	A1	9/2008	Brister et al.
2006/0258929	A1	11/2006	Goode, Jr. et al.	2008/0214918	A1	9/2008	Brister et al.
2006/0264888	A1	11/2006	Moberg et al.	2008/0228051	A1	9/2008	Shults et al.
2006/0276724	A1	12/2006	Freeman et al.	2008/0228054	A1	9/2008	Shults et al.
2007/0016381	A1	1/2007	Kamath et al.	2008/0242961	A1	10/2008	Brister et al.
2007/0027381	A1	2/2007	Stafford	2008/0262330	A1	10/2008	Reynolds et al.
2007/0038044	A1	2/2007	Dobbles et al.	2008/0262469	A1	10/2008	Brister et al.
2007/0060814	A1	3/2007	Stafford	2008/0269673	A1	10/2008	Butoi et al.
2007/0073129	A1	3/2007	Shah et al.	2008/0275313	A1	11/2008	Brister et al.
				2008/0283396	A1	11/2008	Wang et al.
				2008/0287764	A1	11/2008	Rasdal et al.
				2008/0287765	A1	11/2008	Rasdal et al.
				2008/0287766	A1	11/2008	Rasdal et al.

(56)

References Cited

U.S. PATENT DOCUMENTS

2008/0294096	A1	11/2008	Uber et al.	2009/0299156	A1	12/2009	Simpson et al.
2008/0296155	A1	12/2008	Shults et al.	2009/0299162	A1	12/2009	Brauker et al.
2008/0300476	A1	12/2008	Stafford	2009/0299276	A1	12/2009	Brauker et al.
2008/0306368	A1	12/2008	Goode, Jr. et al.	2010/0004597	A1	1/2010	Gyrn et al.
2008/0306434	A1	12/2008	Dobbles et al.	2010/0010324	A1	1/2010	Brauker et al.
2008/0306435	A1	12/2008	Kamath et al.	2010/0010331	A1	1/2010	Brauker et al.
2008/0306444	A1	12/2008	Brister et al.	2010/0010332	A1	1/2010	Brauker et al.
2009/0012379	A1	1/2009	Goode, Jr. et al.	2010/0016687	A1	1/2010	Brauker et al.
2009/0018424	A1	1/2009	Kamath et al.	2010/0016698	A1	1/2010	Rasdal et al.
2009/0030294	A1	1/2009	Petisce et al.	2010/0022855	A1	1/2010	Brauker et al.
2009/0036758	A1	2/2009	Brauker et al.	2010/0030038	A1	2/2010	Brauker et al.
2009/0036763	A1	2/2009	Brauker et al.	2010/0030053	A1	2/2010	Goode, Jr. et al.
2009/0036915	A1	2/2009	Karbowniczek et al.	2010/0030484	A1	2/2010	Brauker et al.
2009/0043181	A1	2/2009	Brauker et al.	2010/0030485	A1	2/2010	Brauker et al.
2009/0043182	A1	2/2009	Brauker et al.	2010/0036215	A1	2/2010	Goode, Jr. et al.
2009/0043525	A1	2/2009	Brauker et al.	2010/0036216	A1	2/2010	Goode, Jr. et al.
2009/0043541	A1	2/2009	Brauker et al.	2010/0036222	A1	2/2010	Goode, Jr. et al.
2009/0043542	A1	2/2009	Brauker et al.	2010/0036223	A1	2/2010	Goode, Jr. et al.
2009/0045055	A1	2/2009	Rhodes et al.	2010/0036225	A1	2/2010	Goode, Jr. et al.
2009/0054866	A1	2/2009	Teisen-Simony et al.	2010/0041971	A1	2/2010	Goode, Jr. et al.
2009/0062633	A1	3/2009	Brauker et al.	2010/0045465	A1	2/2010	Brauker et al.
2009/0062635	A1	3/2009	Brauker et al.	2010/0049014	A1	2/2010	Funderburk et al.
2009/0069658	A1	3/2009	Say et al.	2010/0049024	A1	2/2010	Saint et al.
2009/0076356	A1	3/2009	Simpson et al.	2010/0063373	A1	3/2010	Kamath et al.
2009/0076359	A1	3/2009	Peyser	2010/0069728	A1	3/2010	Funderburk et al.
2009/0076360	A1	3/2009	Brister et al.	2010/0076283	A1	3/2010	Simpson et al.
2009/0076361	A1	3/2009	Kamath et al.	2010/0081908	A1	4/2010	Dobbles et al.
2009/0082693	A1	3/2009	Stafford	2010/0081910	A1	4/2010	Brister et al.
2009/0088787	A1	4/2009	Koike et al.	2010/0087724	A1	4/2010	Brauker et al.
2009/0099436	A1	4/2009	Brister et al.	2010/0096259	A1	4/2010	Zhang et al.
2009/0102678	A1	4/2009	Mazza et al.	2010/0099970	A1	4/2010	Shults et al.
2009/0105569	A1	4/2009	Stafford	2010/0099971	A1	4/2010	Shults et al.
2009/0124877	A1	5/2009	Goode, Jr. et al.	2010/0100113	A1	4/2010	Iio et al.
2009/0124878	A1	5/2009	Goode et al.	2010/0113897	A1	5/2010	Brenneman et al.
2009/0124879	A1	5/2009	Brister et al.	2010/0119693	A1	5/2010	Tapsak et al.
2009/0124964	A1	5/2009	Leach et al.	2010/0121169	A1	5/2010	Petisce et al.
2009/0131768	A1	5/2009	Simpson et al.	2010/0174157	A1	7/2010	Brister et al.
2009/0131769	A1	5/2009	Leach et al.	2010/0174158	A1	7/2010	Kamath et al.
2009/0131776	A1	5/2009	Simpson et al.	2010/0174163	A1	7/2010	Brister et al.
2009/0131777	A1	5/2009	Simpson et al.	2010/0174164	A1	7/2010	Brister et al.
2009/0137886	A1	5/2009	Shariati et al.	2010/0174165	A1	7/2010	Brister et al.
2009/0137887	A1	5/2009	Shariati et al.	2010/0174166	A1	7/2010	Brister et al.
2009/0143659	A1	6/2009	Li et al.	2010/0174167	A1	7/2010	Kamath et al.
2009/0143660	A1	6/2009	Brister et al.	2010/0174168	A1	7/2010	Goode et al.
2009/0156919	A1	6/2009	Brister et al.	2010/0179401	A1	7/2010	Rasdal et al.
2009/0156924	A1	6/2009	Shariati et al.	2010/0179402	A1	7/2010	Goode et al.
2009/0163790	A1	6/2009	Brister et al.	2010/0179404	A1	7/2010	Kamath et al.
2009/0163791	A1	6/2009	Brister et al.	2010/0179408	A1	7/2010	Kamath et al.
2009/0171182	A1	7/2009	Stafford	2010/0179409	A1	7/2010	Kamath et al.
2009/0178459	A1	7/2009	Li et al.	2010/0185065	A1	7/2010	Goode et al.
2009/0182217	A1	7/2009	Li et al.	2010/0185069	A1	7/2010	Brister et al.
2009/0192366	A1	7/2009	Mensingher et al.	2010/0185070	A1	7/2010	Brister et al.
2009/0192380	A1	7/2009	Shariati et al.	2010/0185071	A1	7/2010	Simpson et al.
2009/0192722	A1	7/2009	Shariati et al.	2010/0185072	A1	7/2010	Goode et al.
2009/0192724	A1	7/2009	Brauker et al.	2010/0185075	A1	7/2010	Brister et al.
2009/0192745	A1	7/2009	Kamath et al.	2010/0191082	A1	7/2010	Brister et al.
2009/0192751	A1	7/2009	Kamath et al.	2010/0198035	A1	8/2010	Kamath et al.
2009/0198215	A1	8/2009	Chong et al.	2010/0198036	A1	8/2010	Kamath et al.
2009/0203981	A1	8/2009	Brauker et al.	2010/0204653	A1	8/2010	Gyrn et al.
2009/0204341	A1	8/2009	Brauker et al.	2010/0212583	A1	8/2010	Brister et al.
2009/0212766	A1	8/2009	Olson et al.	2010/0214104	A1	8/2010	Goode et al.
2009/0216103	A1	8/2009	Brister et al.	2010/0217105	A1	8/2010	Yodfat et al.
2009/0240120	A1	9/2009	Mensingher et al.	2010/0217557	A1	8/2010	Kamath et al.
2009/0240128	A1	9/2009	Mensingher et al.	2010/0223013	A1	9/2010	Kamath et al.
2009/0240193	A1	9/2009	Mensingher et al.	2010/0223022	A1	9/2010	Kamath et al.
2009/0242399	A1	10/2009	Kamath et al.	2010/0223023	A1	9/2010	Kamath et al.
2009/0242425	A1	10/2009	Kamath et al.	2010/0228109	A1	9/2010	Kamath et al.
2009/0247855	A1	10/2009	Boock et al.	2010/0228497	A1	9/2010	Kamath et al.
2009/0247856	A1	10/2009	Boock et al.	2010/0240975	A1	9/2010	Goode et al.
2009/0270765	A1	10/2009	Ghesquire et al.	2010/0240976	A1	9/2010	Goode et al.
2009/0287073	A1	11/2009	Boock et al.	2010/0261987	A1	10/2010	Kamath et al.
2009/0287074	A1	11/2009	Shults et al.	2010/0262183	A1	10/2010	Abbott et al.
2009/0292184	A1	11/2009	Funderburk et al.	2010/0262201	A1	10/2010	He et al.
2009/0292185	A1	11/2009	Funderburk et al.	2010/0274107	A1	10/2010	Boock et al.
2009/0299155	A1	12/2009	Yang et al.	2010/0280341	A1	11/2010	Boock et al.
				2010/0286496	A1	11/2010	Simpson et al.
				2010/0298684	A1	11/2010	Leach et al.
				2010/0324392	A1	12/2010	Yee et al.
				2010/0324403	A1	12/2010	Brister et al.

(56)

References Cited

U.S. PATENT DOCUMENTS

2010/0331642	A1	12/2010	Bruce et al.	
2010/0331644	A1	12/2010	Neale et al.	
2010/0331648	A1	12/2010	Kamath et al.	
2010/0331653	A1	12/2010	Stafford	
2010/0331656	A1	12/2010	Mensingher et al.	
2010/0331657	A1	12/2010	Mensingher et al.	
2011/0004085	A1	1/2011	Mensingher et al.	
2011/0009727	A1	1/2011	Mensingher et al.	
2011/0024043	A1	2/2011	Boock et al.	
2011/0024307	A1	2/2011	Simpson et al.	
2011/0027127	A1	2/2011	Simpson et al.	
2011/0027453	A1	2/2011	Boock et al.	
2011/0027458	A1	2/2011	Boock et al.	
2011/0028815	A1	2/2011	Simpson et al.	
2011/0028816	A1	2/2011	Simpson et al.	
2011/0040256	A1	2/2011	Bobroff et al.	
2011/0040263	A1	2/2011	Hordum et al.	
2011/0046467	A1	2/2011	Simpson et al.	
2011/0054275	A1	3/2011	Stafford	
2011/0060196	A1	3/2011	Stafford	
2011/0073475	A1	3/2011	Kastanos et al.	
2011/0077490	A1	3/2011	Simpson et al.	
2011/0082484	A1	4/2011	Saravia et al.	
2011/0106126	A1	5/2011	Love et al.	
2011/0118579	A1	5/2011	Goode et al.	
2011/0118580	A1	5/2011	Goode et al.	
2011/0124992	A1	5/2011	Brauker et al.	
2011/0124997	A1	5/2011	Goode et al.	
2011/0125410	A1	5/2011	Goode et al.	
2011/0130970	A1	6/2011	Goode et al.	
2011/0130971	A1	6/2011	Goode et al.	
2011/0130998	A1	6/2011	Goode et al.	
2011/0137257	A1	6/2011	Gyrn et al.	
2011/0144465	A1	6/2011	Shults et al.	
2011/0178378	A1	7/2011	Brister et al.	
2011/0178461	A1	7/2011	Chong et al.	
2011/0184258	A1	7/2011	Stafford	
2011/0190603	A1	8/2011	Stafford	
2011/0190614	A1	8/2011	Brister et al.	
2011/0201910	A1	8/2011	Rasdal et al.	
2011/0201911	A1	8/2011	Johnson et al.	
2011/0218414	A1	9/2011	Kamath et al.	
2011/0231107	A1	9/2011	Brauker et al.	
2011/0231140	A1	9/2011	Goode et al.	
2011/0231141	A1	9/2011	Goode et al.	
2011/0231142	A1	9/2011	Goode et al.	
2011/0253533	A1	10/2011	Shults et al.	
2011/0257895	A1	10/2011	Brauker et al.	
2011/0263958	A1	10/2011	Brauker et al.	
2011/0270062	A1	11/2011	Goode et al.	
2011/0270158	A1	11/2011	Brauker et al.	
2011/0275919	A1	11/2011	Petisce et al.	
2011/0288574	A1	11/2011	Curry et al.	
2011/0290645	A1	12/2011	Brister et al.	
2011/0313543	A1	12/2011	Brauker et al.	
2011/0319729	A1	12/2011	Donnay et al.	
2011/0319733	A1	12/2011	Stafford	
2011/0319738	A1	12/2011	Woodruff et al.	
2011/0319739	A1	12/2011	Kamath et al.	
2011/0320130	A1	12/2011	Valdes et al.	
2012/0010642	A1	1/2012	Lee et al.	
2012/0035445	A1	2/2012	Boock et al.	
2012/0040101	A1	2/2012	Tapsak et al.	
2012/0046534	A1	2/2012	Simpson et al.	
2012/0078071	A1	3/2012	Bohm et al.	
2012/0108934	A1	5/2012	Valdes et al.	
2016/0354555	A1*	12/2016	Gibson et al.	A61M 5/40

FOREIGN PATENT DOCUMENTS

EP	0098592	1/1984
EP	0127958	12/1984
EP	0320109	6/1989
EP	0353328	2/1990
EP	0390390	10/1990

EP	0396788	11/1990
EP	0286118	1/1995
EP	1048264	11/2000
EP	1177802	2/2002
EP	0987982	1/2007
EP	2060284	5/2009
EP	2201969	6/2010
EP	2327362	6/2011
EP	2335587	6/2011
JP	11-506629	6/1999
JP	2004-520103	7/2004
JP	2004-520898	7/2004
WO	WO-96/39977	5/1996
WO	WO-96/25089	8/1996
WO	WO-96/35370	11/1996
WO	WO-97/21457	6/1997
WO	WO-98/35053	8/1998
WO	WO-98/56293	12/1998
WO	WO-99/33504	7/1999
WO	WO-99/56613	11/1999
WO	WO-00/49940	8/2000
WO	WO-00/59370	10/2000
WO	WO-00/78992	12/2000
WO	WO-01/52935	7/2001
WO	WO-01/54753	8/2001
WO	WO-02/16905	2/2002
WO	WO-02/50534	6/2002
WO	WO-02/058537	8/2002
WO	WO-03/028784	4/2003
WO	WO-03/076893	9/2003
WO	WO-03/082091	10/2003
WO	WO-2004/060436	7/2004
WO	WO-2004/061420	7/2004
WO	WO-2005/084534	9/2005
WO	WO-2005/089103	9/2005
WO	WO-2006/042811	4/2006
WO	WO-2006/108809	10/2006
WO	WO-2008/065646	6/2008
WO	WO-2008/133702	11/2008
WO	WO-2009/062675	5/2009
WO	WO-2010/112521	10/2010
WO	WO-2011/002815	1/2011

OTHER PUBLICATIONS

- Armour, J. C., et al., "Application of Chronic Intravascular Blood Glucose Sensor in Dogs", *Diabetes*, vol. 39, 1990, pp. 1519-1526.
- Aussedat, B., et al., "A User-Friendly Method for Calibrating a Subcutaneous Glucose Sensor-Based Hypoglycemic Alarm", *Biosensors & Bioelectronics*, vol. 12, No. 11, 1997, pp. 1061-1071.
- Bennion, N., et al., "Alternate Site Glucose Testing: A Crossover Design", *Diabetes Technology & Therapeutics*, vol. 4, No. 1, 2002, pp. 25-33.
- Bindra, D. S., et al., "Design and in Vitro Studies of a Needle-Type Glucose Sensor for Subcutaneous Monitoring", *Analytical Chemistry*, vol. 63, No. 17, 1991, pp. 1692-1696.
- Blank, T. B., et al., "Clinical Results From a Non-Invasive Blood Glucose Monitor", *Optical Diagnostics and Sensing of Biological Fluids and Glucose and Cholesterol Monitoring II, Proceedings of SPIE*, vol. 4624, 2002, pp. 1-10.
- Bobbioni-Harsch, E., et al., "Lifespan of Subcutaneous Glucose Sensors and Their Performances During Dynamic Glycaemia Changes in Rats", *Journal of Biomedical Engineering*, vol. 15, 1993, pp. 457-463.
- Brooks, S. L., et al., "Development of an On-Line Glucose Sensor for Fermentation Monitoring", *Biosensors*, vol. 3, 1987/88, pp. 45-56.
- Cass, A. E., et al., "Ferrocene-Medicated Enzyme Electrode for Amperometric Determination of Glucose", *Analytical Chemistry*, vol. 56, No. 4, 1984, 667-671.
- Csoregi, E., et al., "Design and Optimization of a Selective Subcutaneously Implantable Glucose Electrode Based on 'Wired' Glucose Oxidase", *Analytical Chemistry*, vol. 67, No. 7, 1995, pp. 1240-1244.
- Feldman, B., et al., "A Continuous Glucose Sensor Based on Wired Enzyme™ Technology Results from a 3-Day Trial in Patients with

(56)

References Cited

OTHER PUBLICATIONS

- Type 1 Diabetes”, *Diabetes Technology & Therapeutics*, vol. 5, No. 5, 2003, pp. 769-779.
- Feldman, B., et al., “Correlation of Glucose Concentrations in Interstitial Fluid and Venous Blood During Periods of Rapid Glucose Change”, *Abbott Diabetes Care, Inc. Freestyle Navigator Continuous Glucose Monitor Pamphlet*, 2004.
- Gregg, B. A., et al., “Cross-Linked Redox Gels Containing Glucose Oxidase for Amperometric Biosensor Applications”, *Analytical Chemistry*, vol. 62, No. 3, 1990, pp. 258-263.
- Harrison, D. J., et al., “Characterization of Perfluorosulfonic Acid Polymer Coated Enzyme Electrodes and a Miniatured Integrated Potentiostat for Glucose Analysis in Whole Blood”, *Analytical Chemistry*, vol. 60, No. 19, 1988, pp. 2002-2007.
- Heller, A., “Electrical Connection Enzyme Redox Centers to Electrodes”, *Journal of Physical Chemistry*, vol. 96, No. 9, 1990, pp. 3579-3587.
- Isermann, R., “Supervision, Fault-Detection and Fault-Diagnosis Methods—An Introduction”, *Control Engineering Practice*, vol. 5, No. 5, 1997, pp. 639-652.
- Isermann, R., et al., “Trends in the Application of Model-Based Fault Detection and Diagnosis of Technical Processes”, *Control Engineering Practice*, vol. 5, No. 5, 1997, pp. 709-719.
- Johnson, K. W., et al., “In vivo Evaluation of an Electroenzymatic Glucose Sensor Implanted in Subcutaneous Tissue”, *Biosensors & Bioelectronics*, vol. 7, 1992, pp. 709-714.
- Johnson, P. C., “Peripheral Circulation”, *John Wiley & Sons*, 1978, pp. 198.
- Jungheim, K., et al., “How Rapid Does Glucose Concentration Change in Daily Life of Patients with Type 1 Diabetes?”, 2002, pp. 250.
- Jungheim, K., et al., “Risky Delay of Hypoglycemia Detection by Glucose Monitoring at the Arm”, *Diabetes Care*, vol. 24, No. 7, 2001, pp. 1303-1304.
- Kaplan, S. M., “Wiley Electrical and Electronics Engineering Dictionary”, *IEEE Press*, 2004, pp. 141, 142, 548, 549.
- Lortz, J., et al., “What is Bluetooth? We Explain the Newest Short-Range Connectivity Technology”, *Smart Computing Learning Series, Wireless Computing*, vol. 8, Issue 5, 2002, pp. 72-74.
- Maidan, R., et al., “Elimination of Electrooxidizable Interferant-Produced Currents in Amperometric Biosensors”, *Analytical Chemistry*, vol. 64, No. 23, 1992, pp. 2889-2896.
- Malin, S. F., et al., “Noninvasive Prediction of Glucose by Near-Infrared Diffuse Reflectance Spectroscopy”, *Clinical Chemistry*, vol. 45, No. 9, 1999, pp. 1651-1658.
- Mastrototaro, J. J., et al., “An Electroenzymatic Glucose Sensor Fabricated on a Flexible Substrate”, *Sensors and Actuators B*, vol. 5, 1991, pp. 139-144.
- McGarraugh, G., et al., “Glucose Measurements Using Blood Extracted from the Forearm and the Finger”, *TheraSense, Inc.*, 2001, 16 Pages.
- McGarraugh, G., et al., “Physiological Influences on Off-Finger Glucose Testing”, *Diabetes Technology & Therapeutics*, vol. 3, No. 3, 2001, pp. 367-376.
- McKean, B. D., et al., “A Telemetry-Instrumentation System for Chronically Implanted Glucose and Oxygen Sensors”, *IEEE Transactions on Biomedical Engineering*, vol. 35, No. 7, 1988, pp. 526-532.
- Moatti-Sirat, D., et al., “Towards Continuous Glucose Monitoring: In Vivo Evaluation of a Miniaturized Glucose Sensor Implanted for Several Days in Rat Subcutaneous Tissue”, *Diabetologia*, vol. 35, 1992, pp. 224-330.
- Ohara, T. J., et al., “Glucose Electrodes Based on Cross-Linked [Os(bpy)₂C1]^{+/2+} Complexed Poly(1-Vinylimidazole) Films”, *Analytical Chemistry*, vol. 65, No. 23, 1993, pp. 3512-3517.
- Pickup, J., et al., “Implantable Glucose Sensors: Choosing the Appropriate Sensing Strategy”, *Biosensors*, vol. 3, 1987/88, pp. 335-346.
- Pickup, J., et al., “In Vivo Molecular Sensing in Diabetes Mellitus: An Implantable Glucose Sensor with Direct Electron Transfer”, *Diabetologia*, vol. 32, 1989, pp. 213-217.
- Pishko, M. V., et al., “Amperometric Glucose Microelectrodes Prepared Through Immobilization of Glucose Oxidase in Redox Hydrogels”, *Analytical Chemistry*, vol. 63, No. 20, 1991, pp. 2268-2272.
- Poitout, V., et al., “In Vitro and In Vivo Evaluation in Dogs of a Miniaturized Glucose Sensor”, *ASAIO Transactions*, vol. 37, No. 3, 1991, pp. M298-M300.
- Quinn, C. P., et al., “Kinetics of Glucose Delivery to Subcutaneous Tissue in Rats Measured with 0.3-mm Amperometric Microsensors”, *The American Physiological Society*, 1995, E155-E161.
- Reach, G., et al., “Can Continuous Glucose Monitoring Be Used for the Treatment of Diabetes?”, *Analytical Chemistry*, vol. 64, No. 6, 1992, pp. 381-386.
- Rebrin, K., et al., “Automated Feedback Control of Subcutaneous Glucose Concentration in Diabetic Dogs”, *Diabetologia*, vol. 32, 1989, pp. 573-576.
- Roe, J. N., et al., “Bloodless Glucose Measurements”, *Critical Review in Therapeutic Drug Carrier Systems*, vol. 15, Issue 3, 1998, pp. 199-241.
- Sakakida, M., et al., “Development of Ferrocene-Mediated Needle-Type Glucose Sensor as a Measure of True Subcutaneous Tissue Glucose Concentrations”, *Artificial Organs Today*, vol. 2, No. 2, 1992, pp. 145-158.
- Sakakida, M., et al., “Ferrocene-Mediated Needle-Type Glucose Sensor Covered with Newly Designed Biocompatible Membrane”, *Sensors and Actuators B*, vol. 13-14, 1993, pp. 319-322.
- Salehi, C., et al., “A Telemetry-Instrumentation System for Long-Term Implantable Glucose and Oxygen Sensors”, *Analytical Letters*, vol. 29, No. 13, 1996, pp. 2289-2308.
- Schmidt, F. J., et al., “Calibration of a Wearable Glucose Sensor”, *The International Journal of Artificial Organs*, vol. 15, No. 1, 1992, pp. 55-61.
- Schmidtko, D. W., et al., “Measurement and Modeling of the Transient Difference Between Blood and Subcutaneous Glucose Concentrations in the Rat After Injection of Insulin”, *Proceedings of the National Academy of Sciences*, vol. 95, 1998, pp. 294-299.
- Shaw, G. W., et al., “In Vitro Testing of a Simply Constructed, Highly Stable Glucose Sensor Suitable for Implantation in Diabetic Patients”, *Biosensors & Bioelectronics*, vol. 6, 1991, pp. 401-406.
- Shichiri, M., et al., “Glycaemic Control in Pancreatectomized Dogs with a Wearable Artificial Endocrine Pancreas”, *Diabetologia*, vol. 24, 1983, pp. 179-184.
- Shichiri, M., et al., “In Vivo Characteristics of Needle-Type Glucose Sensor—Measurements of Subcutaneous Glucose Concentrations in Human Volunteers”, *Hormone and Metabolic Research Supplement Series*, vol. 20, 1988, pp. 17-20.
- Shichiri, M., et al., “Membrane Design for Extending the Long-Life of an Implantable Glucose Sensor”, *Diabetes Nutrition and Metabolism*, vol. 2, 1989, pp. 309-313.
- Shichiri, M., et al., “Needle-type Glucose Sensor for Wearable Artificial Endocrine Pancreas”, *Implantable Sensors for Closed-Loop Prosthetic Systems*, Chapter 15, 1985, pp. 197-210.
- Shichiri, M., et al., “Telemetry Glucose Monitoring Device With Needle-Type Glucose Sensor: A Useful Tool for Blood Glucose Monitoring in Diabetic Individuals”, *Diabetes Care*, vol. 9, No. 3, 1986, pp. 298-301.
- Shichiri, M., et al., “Wearable Artificial Endocrine Pancreas With Needle-Type Glucose Sensor”, *The Lancet*, 1982, pp. 1129-1131.
- Shults, M. C., et al., “A Telemetry-Instrumentation System for Monitoring Multiple Subcutaneously Implanted Glucose Sensors”, *IEEE Transactions on Biomedical Engineering*, vol. 41, No. 10, 1994, pp. 937-942.
- Sternberg, R., et al., “Study and Development of Multilayer Needle-Type Enzyme-Based Glucose Microsensors”, *Biosensors*, vol. 4, 1988, pp. 27-40.
- Thompson, M., et al., “In Vivo Probes: Problems and Perspectives”, *Clinical Biochemistry*, vol. 19, 1986, pp. 255-261.
- Turner, A., et al., “Diabetes Mellitus: Biosensors for Research and Management”, *Biosensors*, vol. 1, 1985, pp. 85-115.

(56)

References Cited

OTHER PUBLICATIONS

Urdike, S. J., et al., "Principles of Long-Term Fully Implanted Sensors with Emphasis on Radiotelemetric Monitoring of Blood Glucose from Inside a Subcutaneous Foreign Body Capsule (FBC)", *Biosensors in the Body: Continuous in vivo Monitoring*, Chapter 4, 1997, pp. 117-137.

Velho, G., et al., "Strategies for Calibrating a Subcutaneous Glucose Sensor", *Biomedica Biochimica Acta*, vol. 48, 1989, pp. 957-964.

Wilson, G. S., et al., "Progress Toward the Development of an Implantable Sensor for Glucose", *Clinical Chemistry*, vol. 38, No. 9, 1992, pp. 1613-1617.

Ye, L., et al., "High Current Density 'Wired' Quinoprotein Glucose Dehydrogenase Electrode", *Analytical Chemistry*, vol. 65, No. 3, 1993, pp. 238-241.

* cited by examiner

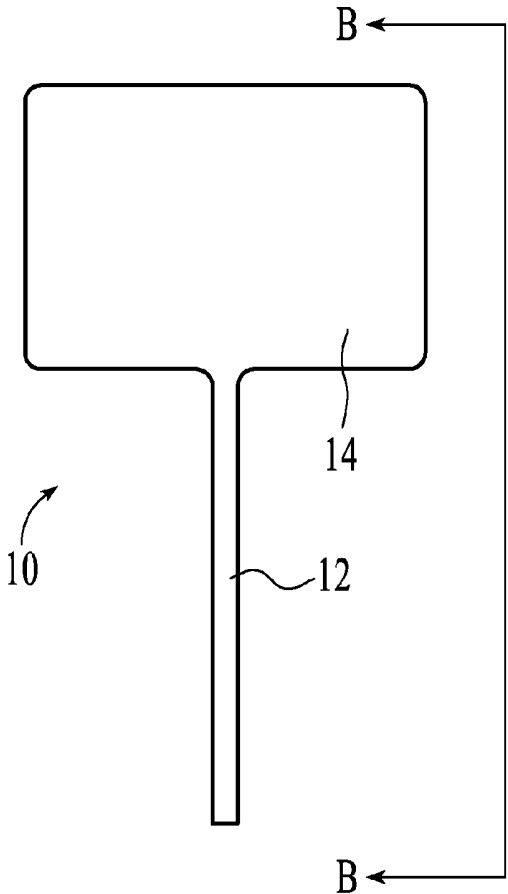


FIG. 1A

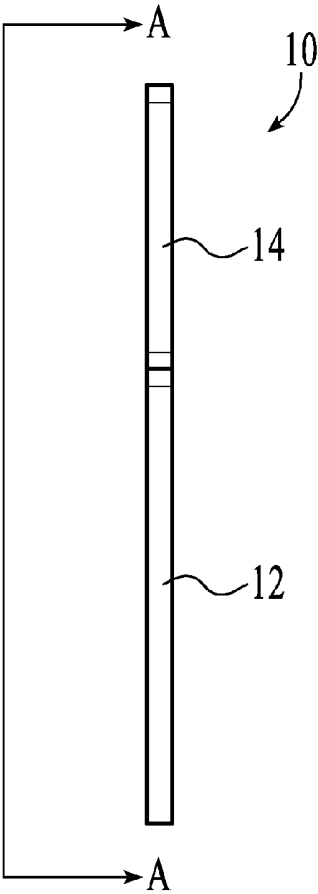


FIG. 1B

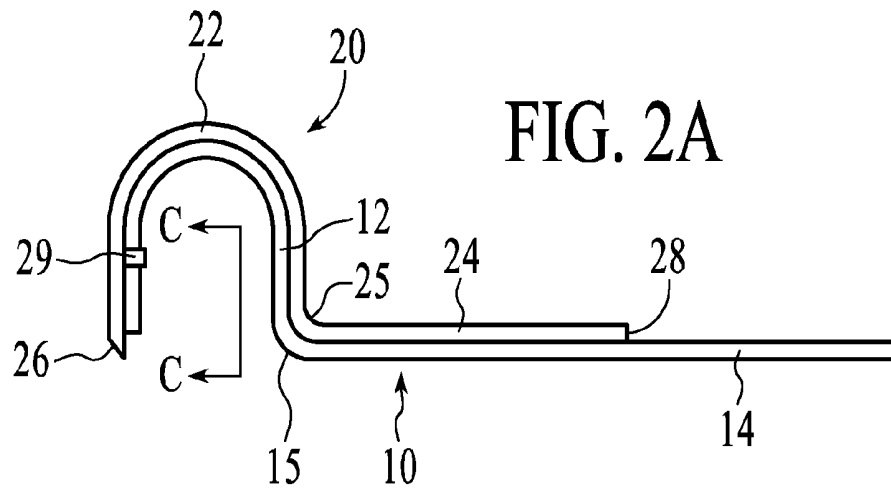


FIG. 2A

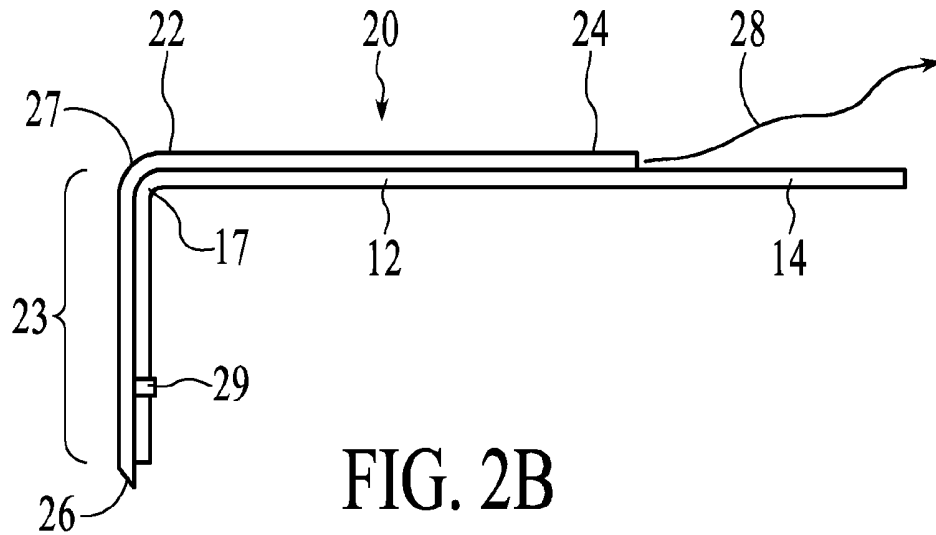


FIG. 2B

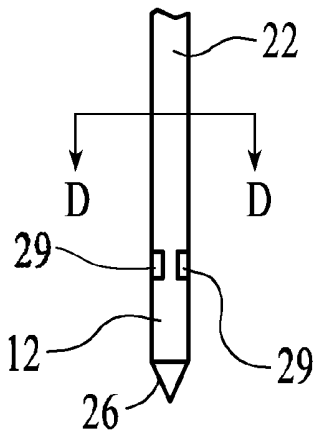


FIG. 2C

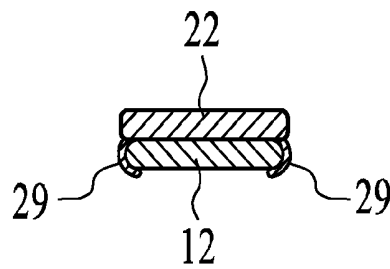


FIG. 2D

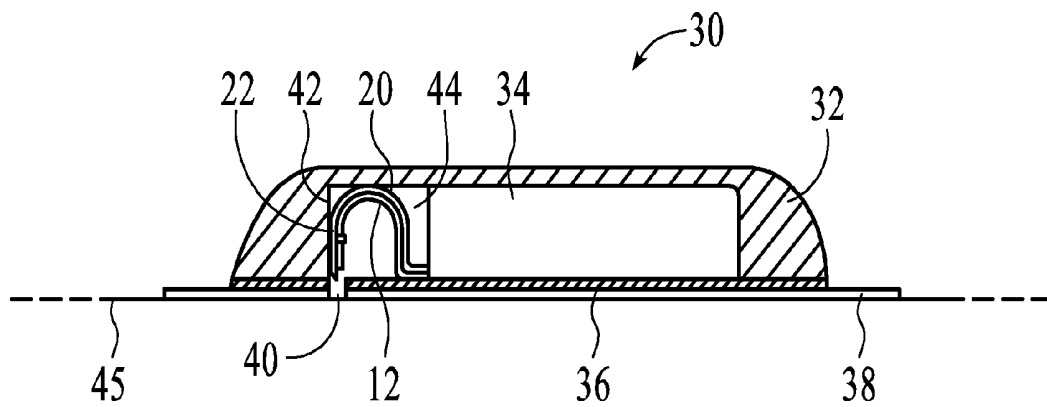


FIG. 3A

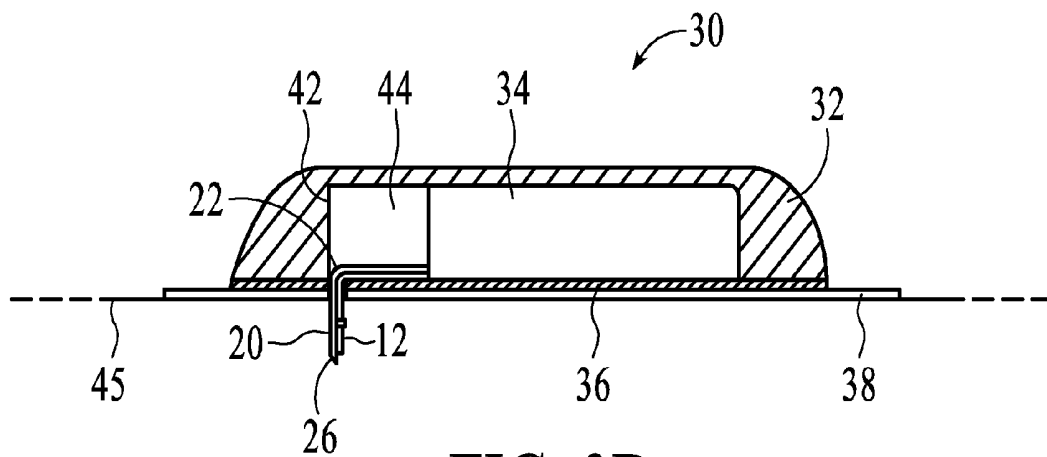


FIG. 3B

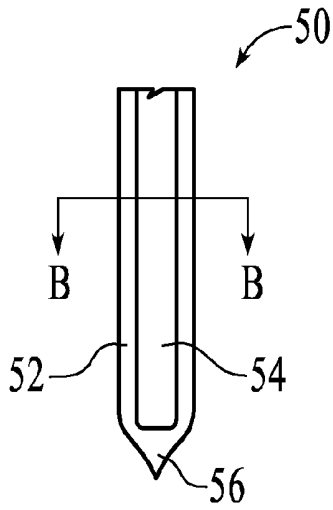


FIG. 4A

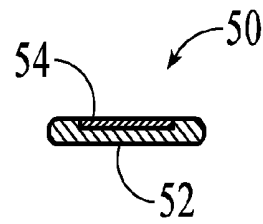


FIG. 4B

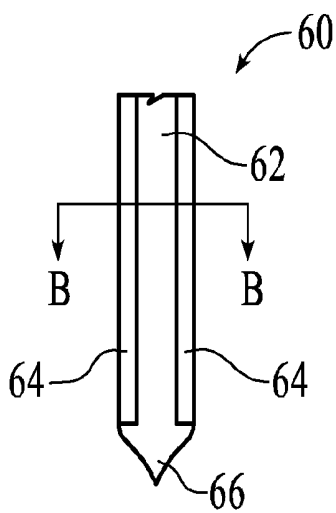


FIG. 5A

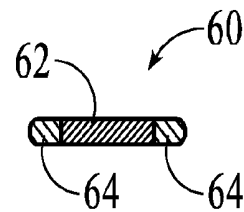


FIG. 5B

SYSTEMS AND METHODS FOR TRANSCUTANEOUSLY IMPLANTING MEDICAL DEVICES

RELATED APPLICATION

The present application claims priority to U.S. provisional patent application No. 61/470,454 filed Mar. 31, 2011, entitled "Systems and Methods for Transcutaneously Implanting Medical Devices", the disclosure of which is incorporated herein by reference for all purposes.

BACKGROUND

The introduction and temporary implantation through the skin, e.g., transcutaneously, percutaneously and/or subcutaneously, of biosensors has become very common in the treatment of patients inflicted with or suffering from any one of many different types of conditions. These implantable sensors include those monitoring a given parameter that indicates a certain bodily condition, e.g., a patient's glucose level, or the actual state of a treatment, e.g., monitoring the concentration of a drug dispensed to the patient or a body substance influenced by the drug.

In recent years, a variety of temporarily implantable sensors have been developed for a range of medical applications for detecting and/or quantifying specific agents, e.g., analytes, in a patient's body fluid such as blood or interstitial fluid. Such analyte sensors may be fully or partially implanted below the epidermis in a blood vessel or in the subcutaneous tissue of a patient for direct contact with blood or other extra-cellular fluid, such as interstitial fluid, wherein such sensors can be used to obtain periodic and/or continuous analyte readings over a period of time.

Certain transcutaneous analyte sensors have an electrochemical configuration in which the implantable portion of these sensors includes exposed electrodes and chemistry that react with a target analyte. At an externally located proximal end of the sensor are exposed conductive contacts for electrical connection with a sensor control unit which is typically mountable on the skin of the patient. One common application of such analyte sensor systems is in the monitoring of glucose levels in diabetic patients. Such readings can be especially useful in monitoring and/or adjusting a treatment regimen which may include the regular and/or emergent administration of insulin to the patient.

A sensor insertion device or kit is typically provided with such analyte monitoring systems for inserting the sensor into a patient. The insertion kit includes an introducer which typically has a sharp, rigid structure adapted to support the sensor during its transcutaneous insertion. Some introducers are in the form of needles having a slotted or hollow configuration in which a distal portion of the sensor is slidably carried to the desired implantation site, e.g., subcutaneous site, after which the insertion needle can be slidably withdrawn from the implanted sensor. Often, the insertion kit also includes an insertion gun for automatically or semi-automatically driving the introducer and attached sensor to within the skin. Implantation of a sensor with such an insertion device typically involves using the insertion gun to drive the introducer and pre-loaded sensor into the skin of the patient. The introducer is retracted into the insertion gun, leaving the sensor implanted within the patient.

While such sensor insertion tools can greatly assist a user in effectively and efficiently implanting transcutaneous sensors, they are not without their drawbacks. As they are designed to be substantially automatic, the insertion guns

tend to be mechanically complex, involving numerous static and moving parts. With the added complexity of such tools are significant costs in designing and fabricating them, contributing significantly to the overall cost of the sensor systems. In addition to the financial and manufacturing-related drawbacks, there are significant clinical consequences to using such transcutaneous sensor insertion tools.

The subcutaneous or other placement of such sensors, or any medical device, produces both short-term and longer-term biochemical and cellular responses which may lead to the development of a foreign body capsule around the implant. Consequently, this encapsulation may reduce the flux of an analyte to the sensor, i.e., may reduce the sensitivity or accuracy of the sensor function, often requiring numerous calibrations over the course of the sensor's implantation period. The extent of the immune response presented by implantable sensors, as well as the amount of pain and discomfort felt by the patient, are exacerbated by the size of the sensor introducer and/or the implantable portion of the sensor, often referred to as the sensor tail. With sensor introducers that carry the sensor within an interior or substantially interior space, there is naturally a limit on the extent to which the cross-sectional dimension of the introducer can be reduced.

Accordingly, it would be highly desirable to provide a sensor introducer and associated sensor design, and/or a combined assembly, which do not require a separate insertion tool for their transcutaneous insertion, thereby minimizing the number of components involved, and reducing mechanical complexity and manufacturing costs. It would be additionally advantageous if the respective and combined dimensions and configurations of the introducer and sensor were further reduced to minimize the trauma, pain and immune response to sensor insertion/implantation.

INCORPORATION BY REFERENCE

The following patents, applications and/or publications are incorporated herein by reference for all purposes: U.S. Pat. Nos. 4,545,382; 4,711,245; 5,262,035; 5,262,305; 5,264,104; 5,320,715; 5,509,410; 5,543,326; 5,593,852; 5,601,435; 5,628,890; 5,820,551; 5,822,715; 5,899,855; 5,918,603; 6,071,391; 6,103,033; 6,120,676; 6,121,009; 6,134,461; 6,143,164; 6,144,837; 6,161,095; 6,175,752; 6,270,455; 6,284,478; 6,299,757; 6,338,790; 6,377,894; 6,461,496; 6,503,381; 6,514,460; 6,514,718; 6,540,891; 6,560,471; 6,579,690; 6,591,125; 6,592,745; 6,600,997; 6,605,200; 6,605,201; 6,616,819; 6,618,934; 6,650,471; 6,654,625; 6,676,816; 6,676,819; 6,730,200; 6,736,957; 6,746,582; 6,749,740; 6,764,581; 6,773,671; 6,881,551; 6,893,545; 6,932,892; 6,932,894; 6,942,518; 7,167,818; 7,299,082; 7,381,184; 7,618,369; 7,697,967 and 7,885,698; U.S. Published Application Nos. 2004/0186365; 2005/0182306; 2007/0056858; 2007/0068807; 2007/0227911; 2007/0233013; 2008/0081977; 2008/0161666; 2009/0054748; 2009/0247857; and 2010/0081909; and U.S. patent application Ser. Nos. 11/396,135, 11/537,984, 12/131,012; 12/242,823; 12/363,712; 12/698,124; 12/714,439; 12/807,278; 12/842,013; and 12/848,075.

SUMMARY

Embodiments of implantable medical devices and of methods, systems and devices for positioning at least a portion of the medical devices beneath the epidermal layer of skin, e.g., transcutaneously, are described. A portion or the entirety of the medical devices may be implanted in a blood

vessel, subcutaneous tissue, or other suitable body location. Certain embodiments of the implantable medical devices are in vivo analyte sensors for the continuous and/or automatic detection and measurement of one or more selected analytes.

Certain system embodiments configured for transcutaneously implanting a medical device include an introducer having at least a portion engageable with at least a portion of the medical device, wherein the introducer is at least partially formed from a shape memory material, and an activating component to activate the introducer to transition from a first operative shape memory state to a second operative shape memory state, wherein said transition translates the medical device engaged with the introducer from a position above the skin surface to at least partially through the skin surface. In certain of these embodiments, the first operative shape memory state is a heat-unstable shape and the second operative shape memory state is a heat-stable shape, wherein the activating component may include an electrical current generating component electrically coupled to the introducer.

In certain aspects of these system embodiments, the first operative shape memory state is a physically loaded configuration and the second operative shape memory state is a physically unloaded configuration, wherein the activating component may include a driving mechanism mechanically coupled to the introducer.

In certain embodiments, the subject systems may include a housing configured for placement on a skin surface of a host, wherein the introducer is configured to be at least partially positioned within the housing when in the first operative shape memory state. The housing may include a compartment within which the introducer is configured to be at least partially contained when in the first operative shape memory state.

In certain embodiments, the portion of the introducer engageable with the medical device defines a major axis wherein during the transition from the first operative shape memory state to the second operative shape memory state, the introducer changes shapes along the major axis. Further, in certain embodiments, the subject introducers may have at least one coupling member for securing the medical device to the introducer at least when in the first operative memory state. The shape memory materials suitable for fabricating the subject introducers include, but are not limited to, nickel-titanium, copper-zinc-aluminum-nickel, copper-aluminum-nickel, and alloys of zinc, copper, gold and iron.

In a particular system of the present disclosure adapted for transcutaneously implanting a medical device, the system includes a housing configured for placement on a skin surface of a host, an introducer configured to be at least partially positioned within the housing and having at least a portion engageable with at least a portion of the medical device, wherein the introducer is at least partially formed from a shape memory material, and an electrical current generating component electrically coupled to the introducer for activating the introducer to transition from a heat-unstable shape to a heat-stable shape, wherein said transition translates the medical device engaged with the introducer from a position within the housing to at least partially through the skin surface. The electrical current generating component may include a battery contained within the housing, which battery may also be used to power a control unit for operating the medical device. In other embodiments, the battery may be provided separately, i.e., not contained within the housing.

In other embodiments for transcutaneously implanting a medical device, a system may include a housing configured

for placement on a skin surface of a host, an introducer configured to be at least partially positioned within the housing and having at least a portion engageable with at least a portion of the medical device, wherein the introducer is at least partially formed from a shape memory material, and a driving mechanism mechanically coupled to the introducer for moving the introducer relative to the housing in order to transition from a loaded configuration to an unloaded configuration, wherein said transition translates the medical device engaged with the introducer from a position within the housing to at least partially through the skin surface. The system housing may include a compartment configured to physically retain the introducer in the loaded configuration.

The present disclosure is also directed to an in vivo analyte monitoring system including a housing configured for placement on a skin surface of a host, a control unit housed within the housing, an in vivo analyte sensor having a proximal portion and a distal portion, wherein the proximal portion is operatively coupleable to the control unit, a sensor introducer at least partially positioned within the housing, wherein the introducer is at least partially comprised of a shape memory material and wherein a portion of the introducer is engageable with the sensor distal portion, and a transitioning component to transition the introducer from a first operative shape memory state to a second operative shape memory state, wherein said transitioning translates the sensor distal portion from a position within the housing to at least partially through the skin surface.

In certain embodiments, the portion of the introducer engageable with the sensor distal portion may have a crosswise dimension substantially similar to, or alternatively different than, that of the sensor distal portion. For example, the portion of the introducer engageable with the sensor distal portion may have a crosswise dimension smaller than that of the sensor distal portion. In certain aspects, the sensor distal portion and the portion of the introducer engageable with the sensor distal portion may have respective configurations which enable a nesting arrangement between them. This engageable portion of the introducer may have any suitable shape when in the first operative shape memory state including but not limited to a U-shaped configuration.

Other features of the introducer may include a distal tip configured to substantially atraumatically pierce the skin surface, and/or at least one coupling member for securing the medical device, e.g., the sensor distal portion, to the introducer at least when the introducer is in the first operative memory state.

The present disclosure includes embodiments directed to transcutaneously implantable medical devices which are substantially self-implanting without the need for a separate introducer or other instrument to facilitate the device's implantation through the skin. In certain embodiments, these medical devices include a flexible, elongated substrate having a distal tip configured to substantially atraumatically pierce the skin surface, wherein the substrate is formed from a non-conductive material, and at least one spine extending along a length of the substrate, wherein the at least one spine is formed from a shape memory alloy, and wherein the medical device is translatable from a first operative shape memory state to a second operative shape memory state. The shape memory material used to fabricate these medical devices may include, but are not limited to, one or more of nickel-titanium, copper-zinc-aluminum-nickel, copper-aluminum-nickel, and alloys of zinc, copper, gold and iron. Depending, at least in part, on the type of shape memory material employed, the first operative shape memory state of

the medical device may be a heat-unstable shape and the second operative shape memory state may be a heat-stable shape. In certain embodiments, the first operative shape memory state is a compressed configuration and the second operative shape memory state is an uncompressed configuration.

The construct of these self-inserting medical devices, in certain embodiments, enable them to function as electrochemical sensors. In certain embodiments, one or more of the spines may also function as an electrode. These electrochemical sensors may include analyte sensors, such as glucose sensors.

The present disclosure is also directed to methods for transcutaneously implanting a medical device. In certain embodiments, at least a portion of the medical device is flexible. Such methods may involve providing an introducer, wherein the introducer is at least partially formed from a shape memory material, engaging at least the flexible portion of the medical device with the introducer, wherein the engaged introducer and medical device are in a nested arrangement, and wherein when the introducer is in a first operative shape memory state, positioning a skin-penetrating end of the introducer adjacent to the skin surface, and transitioning the introducer from the first operative shape memory state to a second operative shape memory state, wherein the introducer penetrates through the skin surface and transcutaneously implants at least a portion of the flexible portion of the medical device beneath the skin surface.

In certain embodiments of the above-described method, transitioning the introducer from the first operative shape memory state to the second operative shape memory state includes applying an electrical current to the introducer. In certain embodiments, the step of engaging the flexible portion of the medical device with the introducer in a nested arrangement includes cooling the introducer to a predefined temperature while the medical device is structurally aligned along a major axis of the introducer.

In certain embodiments of the above-described method, transitioning the introducer from the first operative shape memory state to the second operative shape memory state includes releasing the introducer from a confined space. As such, the step of engaging the flexible portion of the medical device with the introducer in a nested arrangement may include loading the introducer to a reduced profile while the medical device is structurally aligned along a major axis of the introducer and positioning the introducer and nested sensor in the confined space. This confined space may be provided within a housing that is configured for placement on the skin surface.

The subject methods may also include the removal of one or both the introducer and medical device from the skin subsequent to implantation. In certain embodiments, the methods may further include removing the introducer from the skin while leaving the transcutaneously implanted medical device within the patient, or alternatively, maintaining the introducer within the skin along with the transcutaneously implanted medical device for the useful life of the medical device. Such explanation of the introducer and/or introducer and medical device, for example, may be accomplished via manual retraction or by transitioning the introducer from the second operative shape memory state back to the first operative shape memory state.

These and other objects, advantages, and features of the disclosure will become apparent to those persons skilled in the art upon reading the details of the disclosure as more fully described below.

BRIEF DESCRIPTION OF THE DRAWINGS

The disclosure is best understood from the following detailed description when read in conjunction with the accompanying drawings. It is emphasized that, according to common practice, the various features of the drawings are not to scale. On the contrary, the dimensions of the various features are arbitrarily expanded or reduced for clarity. Included in the drawings are the following figures:

FIGS. 1A and 1B are front and side views, respectively, of a transcutaneously implantable sensor of the present disclosure, where the views are taken along lines A-A and B-B, respectively, of the other Figure;

FIG. 2A is a side view of an introducer of the present disclosure with the sensor of FIGS. 1A and 1B operatively engaged with the introducer, collectively in a first or pre-insertion state;

FIG. 2B is a side view of the introducer and sensor of FIG. 2A, collectively in a second or post-insertion state;

FIG. 2C is an enlarged view of a distal end portion taken along line C-C of FIG. 2A;

FIG. 2D is a cross-sectional view taken along line D-D of FIG. 2C;

FIGS. 3A and 3B are side cross-sectional views of a sensor system of the present disclosure operatively mounted on the skin of a patient, where FIG. 3A shows the introducer and sensor in operative engagement in a first or pre-insertion state and FIG. 3B shows the introducer and sensor in operative engagement in a second or post-insertion state;

FIG. 4A is an enlarged fragmented view of a distal end portion of one embodiment of a sensor of the present disclosure;

FIG. 4B is a cross-sectional view of the sensor of FIG. 4A taken along line B-B;

FIG. 5A is an enlarged fragmented view of a distal end portion of one embodiment of a sensor of the present disclosure; and

FIG. 5B is a cross-sectional view of the sensor of FIG. 5A taken along line B-B.

DETAILED DESCRIPTION

Before the subject devices, systems and methods are described, it is to be understood that this disclosure is not limited to particular embodiments described, as such may, of course, vary. It is also to be understood that the terminology used herein is for the purpose of describing particular embodiments only, and is not intended to be limiting, since the scope of the present disclosure will be limited only by the appended claims.

Where a range of values is provided, it is understood that each intervening value, to the tenth of the unit of the lower limit unless the context clearly dictates otherwise, between the upper and lower limits of that range is also specifically disclosed. Each smaller range between any stated value or intervening value in a stated range and any other stated or intervening value in that stated range is encompassed within the disclosure. The upper and lower limits of these smaller ranges may independently be included or excluded in the range, and each range where either, neither or both limits are included in the smaller ranges is also encompassed within the disclosure, subject to any specifically excluded limit in the stated range. Where the stated range includes one or both of the limits, ranges excluding either or both of those included limits are also included in the disclosure.

Unless defined otherwise, all technical and scientific terms used herein have the same meaning as commonly

understood by one of ordinary skill in the art to which this disclosure belongs. As used herein, the terms transcutaneous, subcutaneous and percutaneous and forms thereof may be used interchangeably.

All publications mentioned herein are incorporated herein by reference to disclose and describe the methods and/or materials in connection with which the publications are cited. It is understood that the present disclosure supersedes any disclosure of an incorporated publication to the extent there is a contradiction. The publications discussed herein are provided solely for their disclosure prior to the filing date of the present application. Nothing herein is to be construed as an admission that the present disclosure is not entitled to antedate such publication by virtue of prior disclosure. Further, the dates of publication provided may be different from the actual publication dates which may need to be independently confirmed.

It must be noted that as used herein and in the appended claims, the singular forms "a", "an", and "the" include plural referents unless the context clearly dictates otherwise.

As will be apparent to those of skill in the art upon reading this disclosure, each of the individual embodiments described and illustrated herein has discrete components and features which may be readily separated from or combined with the features of any of the other several embodiments without departing from the scope or spirit of the present disclosure.

Generally, the present disclosure is directed to transcutaneously implantable or partially implantable medical devices and to devices, systems and methods for transcutaneously implanting such implantable devices. In certain embodiments, the present disclosure is directed to implantable medical devices which are configured to be substantially self-implanting without the need for a separate skin-penetrating structure. While embodiments of the subject disclosure are primarily described below with respect to analyte sensors and analyte monitoring devices, systems and methods, such as for glucose monitoring, such description is in no way intended to limit the scope of the disclosure. It is understood that the subject disclosure is applicable to any medical device in which at least a portion of the device is intended to be implanted within the body of a patient.

Referring now to the drawings and to FIGS. 1A and 1B in particular, there is shown an embodiment of a partially implantable sensor **10** of the present disclosure. Embodiments of sensor **10** are for the in vivo monitoring or measurement of a physiological condition or state or of a value of a naturally-occurring or unnaturally-occurring substance or agent within the body. As such, sensor **10** may be an analyte sensor (electrochemical, optical, etc.) wherein at least a portion of the sensor is positionable beneath the skin of the user or host for the in vivo determination of a concentration of an analyte in a body fluid, e.g., interstitial fluid, blood, urine, etc. Alternatively or additionally, sensor **10** may be positionable in a body vessel such as a vein, artery, or other portion of the body. Sensor **10** may also have an ex vivo portion which is positionable outside the body, i.e., above the skin surface, and configured to be coupled to a component of a medical device system such as to a control unit **34** mounted on the skin of a patient (see FIGS. 3A and 3B). The intended site and depth of implantation may affect the particular shape, components and configuration of sensor **10** and its in vivo and ex vivo portions, respectively. Examples of such sensors and associated analyte monitoring systems can be found in U.S. Pat. Nos. 6,134,461; 6,175,752; 6,284,478; 6,560,471; 6,579,690; 6,746,582; 6,932,892; 7,299,082; 7,381,184; 7,618,369; 7,697,967 and 7,885,

698; and U.S. Patent Application Publication Nos. 2008/0161666, 2009/0247857 and 2010/0081909, the disclosures of each of which are incorporated herein by reference.

Although the subject sensors in at least some embodiments have uniform dimensions along the entire length of the sensor, in the illustrated embodiment, sensor **10** has a distal portion **12** and a proximal portion **14** with different widths. Distal portion **12**, also referred to as the tail portion of the sensor, has a relatively narrow width to facilitate subcutaneous implantation of at least a portion of its length, while proximal portion **14** has a relatively wider width to facilitate coupling with an external control unit **34** (see FIGS. 3A and 3B). In certain embodiments, distal portion **12** is substantially narrower than proximal portion **14**, having a strip-like or wire-like configuration, while proximal portion **14** has a substantially flat, planar configuration. The cross-wise dimension, i.e., the thickness of flat or strip configurations and the diameter of wire-like configurations, of at least distal portion **12** is relatively thin, having a cross-wise dimension in the range from about 0.02 mm (20 μ m) to about 1.2 mm (1,200 μ m), and more typically from about 0.2 mm (200 μ m) to about 0.6 mm (600 μ m).

Where sensor **10** is an electrochemical sensor, the sensor includes at least one working electrode formed on a substrate. The sensor may also include at least one counter electrode and/or at least one reference electrode and/or at least one counter/reference electrode. The sensor substrate may be formed using a variety of non-conducting materials, including, for example, polymeric or plastic materials and ceramic materials; however, at least the implantable portion of sensor **10**, i.e., at least a portion of distal portion **12**, is made of a flexible, bendable and/or deformable material. Suitable materials for a flexible substrate include, for example, thermoplastics such as polycarbonates, polyesters (e.g., Mylar™ and polyethylene terephthalate (PET)), polyvinyl chloride (PVC), polyurethanes, polyethers, polyamides, polyimides, or copolymers of these thermoplastics, such as PETG (glycol-modified polyethylene terephthalate).

Analytes measurable by the subject sensors may include but are not limited to glucose, lactate, acetyl choline, amylase, bilirubin, cholesterol, chorionic gonadotropin, creatine kinase (e.g., CK-MB), creatine, DNA, fructosamine, glucose, glutamine, growth hormones, hormones, ketones, lactate, peroxide, prostate-specific antigen, prothrombin, RNA, thyroid stimulating hormone, and troponin. Other of the subject sensors may be configured to detect and measure drugs, such as, for example, antibiotics (e.g., gentamicin, vancomycin, and the like), digitoxin, digoxin, drugs of abuse, theophylline, and warfarin. Two or more analytes and/or drugs may be monitored at the same or different times, with the same or different analyte sensor(s).

Sensors described herein may be configured for monitoring the level of an analyte over a time period which may range from minutes, hours, days, weeks, one month or longer. Of interest are analyte sensors, such as glucose sensors, that have an in vivo operational life of about one hour or more, e.g., about a few hours or more, e.g., about a few days or more, e.g., about three days or more, e.g., about five days or more, e.g., about seven days or more, e.g., about several weeks or months.

As mentioned previously, eliminating the need for a separate sensor insertion tool, e.g., an insertion gun, for transcutaneously implanting the subject sensors would provide the benefits of fewer components, reduced costs, and increased ease of use for a user of such sensors. The present disclosure provides an introducer or inserter (both terms are used interchangeably herein) for transcutaneously implant-

ing a medical device, such as sensor **10**, without the need for a separate tool or instrument for driving and/or retracting the introducer through the skin. Instead, the introducer or inserter is driven or translated solely by its shape-shifting material characteristics. More particularly, the subject introducers or inserters are made, at least in part, of a shape memory alloy (SMA) having memory characteristics which function to define one operative configuration which is transitionable or convertible to another operative configuration.

In certain embodiments, the state transition is a reversion from a heat-unstable configuration to an original, heat-stable configuration upon the application of heat to the SMA structure. In the manufacturing process, the original, heat-stable or "austenitic" state of the SMA structure is deformed to a new, heat-unstable or "martensitic" state when cooled below the temperature at which the SMA is transformed from the austenitic state to the martensitic state. The temperature at which this martensitic transformation begins is usually referred to as M_s and the temperature at which it finishes is referred to as M_f . When an article thus deformed is heated to the temperature at which the alloy starts to revert back to austenite, referred to as A_s (A_f being the temperature at which the reversion is complete), the deformed object will begin to return to its original, heat-stable configuration. The martensitic and austenitic temperatures of a particular SMA structure are predefined based on the type of SMA material from which the structure is formed.

In other embodiments, the transition of the SMA structure from one operative configuration to another is the reversion of the structure from a physically stressed or confined state to an unstressed, unconfined original state upon the removal of an externally applied force. During the manufacturing process, the SMA structure is formed to a selected unloaded or unstressed shape. When the structure is loaded or stressed, typically by positioning it in a confined space, typically to a lower-profile state, a bias toward the original, unstressed state is created. When the structure is released or the confinement removed, the biased SMA structure returns to its original, unloaded, unstressed condition. This type of memory characteristic is sometimes referred to as superelasticity or pseudoelasticity.

Suitable shape memory alloys for use in the introducers of the present disclosure include but are not limited to nickel-titanium (NiTi), copper-zinc-aluminum-nickel, copper-aluminum-nickel, and other alloys of zinc, copper, gold, and iron.

The subject introducers are structurally configured to accommodate the shape and size of the medical device, such as a sensor, to be transcutaneously positioned. As many medical devices configured for transcutaneous implantation, such as the in vivo analyte sensors discussed herein, are designed to minimize pain and trauma to the patient, their implantable portions are very narrow and elongated. Accordingly, in many embodiments, the subject introducers have a shape and cross-sectional dimension to substantially match those of the medical device, e.g., very narrow and elongated needle-type structure, so as to minimize pain and trauma. However, in certain embodiments, the introducer may have a shape and/or size which are dissimilar to those of the medical device to be implanted. Because minimizing pain and trauma is an important objective in treating patients, in some embodiments, the smaller the introducer, the better. In some cases, the introducer may have a cross-wise dimension that is smaller than that of the medical device as long as the introducer is able to retain the medical

device in a compressed condition prior to transcutaneous insertion and to effectively advance it through the skin when activated.

For certain of the introducer embodiments of the present disclosure, the subject sensors, such as sensor **10** of FIGS. **1A** and **1B**, are operatively coupled with the subject introducers prior to implantation of the sensor, wherein the respective major axes of the insertion portion of introducer and the sensor distal or tail portion, i.e., their longitudinal axes, are substantially parallel and in substantial physical contact with each other. The flexibility of the sensor substrate allows it to be engaged with and deformable or bendable in tandem with the introducer as the latter transitions between its heat-unstable and heat-stable states. One such operative engagement between a shape memory introducer **20** of the present disclosure and a medical device, such as sensor **10**, is illustrated in FIGS. **2A-2D**. In particular, FIG. **2A** shows the introducer-sensor assembly in a pre-implantation or pre-insertion state in which at least a distal portion of sensor **10** has been deformed from its naturally flat straight condition, as illustrated in FIGS. **1A** and **1B**, to a shape in which it nests with inserter **20** when the inserter is in its heat-unstable, martensitic state (in the case of heat-transitionable memory embodiments of the introducer) or in its stressed, loaded or confined state (in the case of the elastic memory embodiments of the introducer). FIG. **2B**, on the other hand, shows the inserter-sensor assembly in a post-implantation or post-insertion state in which inserter **20** has been transitioned to its heat-stable, austenitic state (in the case of heat-transitionable memory embodiments of the introducer) or to its unstressed, unloaded or unconfined state (in the case of elastic memory embodiments of the introducer). For purposes of this description, the pre-implantation/pre-insertion state of FIG. **2A** may be referred to as a first operative shape memory configuration or shape, and the post-implantation/post-insertion state of FIG. **2B** may be referred to as a second operative shape memory configuration or shape.

With reference to FIG. **2A**, the first operative shape of inserter **20** includes a U-shaped distal portion **22** transitioning at a bend **25** to a straight proximal portion **24** where the transition bend has an angle of about 90° . The corresponding first operative shape of sensor **10** substantially conforms to that of inserter **20**, i.e., sensor distal portion **12** has taken on the U-shape of introducer distal portion **22** and sensor proximal portion **14** has aligned with introducer proximal portion **24** with a transition bend **15** therebetween. Introducer **20** may be configured to have any suitable heat-unstable or elastically-deformable shape or configuration, provided the resulting profile of the introducer-sensor assembly allows it to be positionable within the structure or housing used for delivering or carrying the assembly prior to transcutaneous implantation, as discussed in greater detail below. Accordingly, the pre-implantation introducer-sensor assembly may have any suitable first operative configuration including, but not limited to V-shaped, C-shaped, coiled, looped, sinusoidal, etc.

With reference to FIG. **2B**, the second operative shape of introducer **20** includes a length **23** of distal portion **22** which is shaped for transcutaneous implantation, which length portion **23** is typically substantially straight and substantially corresponds to the length of sensor distal portion **12** which is intended for transcutaneous implantation. As the entire distal portion **12** of sensor **10** is not intended to be implanted, introducer **20**, in its second operative state, includes a transition bend **27** within or about distal portion **22** wherein the remaining proximal end portion of introducer

20 has a substantially straight configuration, providing a cooperative L-shaped configuration when in the second operative state. As with the first operative shape of sensor 10, the corresponding second operative shape of sensor 10 is substantially conforming to that of introducer 20, i.e., having a transition bend 17 between distally and proximally extending straight portions. Transition bends 17 and 27 within the sensor and introducer, respectively, may have any suitable angle, wherein the transition angle may be selected to provide a skin penetration path that is substantially transverse to the skin surface, i.e., at about a 90° angle. Alternatively, the transition angle may be in the range from less than 90° degrees to about 135°, but may be more or less, to provide a skin penetration path that is angled with respect to the skin surface.

It is noted that the respective first and second operative configurations of introducer 20 may have any suitable shape for the given application, insertion site, etc., with the respective transition bends 25 and 27 of introducer 20 in the first and second operative configurations provided at any suitable location along the length of the introducer, including within the distal portion 22, as illustrated, or substantially between the distal and proximal portions. Further, bends 25 and 27 may have any suitable angle including angles greater or less than the illustrated 90°. Further, the respective locations of bends 25 and 27 along the length of introducer 20 may differ from each other, as illustrated, or introducer 20 may be configured such that the bends in the first and second operative configurations coincide at the same location along the introducer's length. For example, in the illustrated embodiment, bend 27 in FIG. 2B (when introducer 20 is in the second operative state) is located substantially closer to the distal tip 26 of the introducer than bend 25 in FIG. 2A (when introducer 20 is in the first operative state). In any embodiment, when in the second operative configuration, the length or portion 23 of introducer 20, as well as the corresponding length/portion of sensor 10 extending distally of transition bend 27, are typically those length portions which are positioned beneath the skin surface upon transcutaneous implantation.

As best illustrated in FIGS. 2C and 2D, introducer 20 may include one or more coupling members 29 for securing sensor 10 to introducer 20 or for guiding sensor 10 along the transcutaneous insertion path enabled by introducer 20 upon implantation. In the illustrated embodiment, the coupling member 29 includes tabs or protrusions positioned on opposing sides of introducer 20 which engage sensor 10 about its width. Coupling member 29 may be positioned at any suitable location along the length of introducer 20, such as about distal portion 22, as illustrated. The securement provided by coupling member 29 may be releasable or permanent. In certain embodiments, introducer 20 is configured and intended to be withdrawn from the skin after transcutaneous insertion of sensor 10. As such, coupling member 29 is configured to enable introducer 20 to be slidably removable from implanted sensor 10. To this end, coupling member 29 may extend laterally from introducer 20 only to the extent necessary to maintain sensor 10 in longitudinal alignment with introducer 20 and function as guides during the pre- and post-implantation states, while allowing introducer 20 to be slidably removed from the skin in a retrograde direction after transcutaneous implantation of sensor 10. In embodiments where introducer 20 is to remain coupled and implanted with sensor 10 after transcutaneous implantation, coupling member 29 may be configured to completely engage sensor 20, and may even fully crosswise encircle the sensor.

It is noted that while a coupling member 29 is provided in the illustrated embodiment, no such member may be needed in certain embodiments where the spring bias placed on flexed sensor 10 via the physical confinement by introducer 20 in the first (and sometimes the second) operative state is sufficient to maintain the sensor's engagement and alignment with the introducer prior to and during its transcutaneous implantation. To provide such sufficient spring-biased engagement between the sensor and the introducer, the sensor may need to be nested within or constrained in a somewhat confined space or plane defined by the introducer, at least when in the first operative state, as illustrated in FIG. 2A. More specifically, sensor 10 is nested within the concave side of introducer 20, where such "nesting" may place a sufficient spring bias along the longitudinal axis of sensor 10 to maintain its static position against the introducer prior to and during transcutaneous insertion.

In certain embodiments, the size of an SMA introducer is comparable to the size of the device to be transcutaneously implanted, i.e., the larger the sensor, the larger the introducer. The introducer should not be any larger than necessary as the larger the introducer, the more energy (i.e., electrical current or physical force) required to activate the shape transition of the introducer. However, the introducer should be large enough to enable the sensor to penetrate the skin without bearing much frictional resistance. Accordingly, introducers for use with the sensors having the dimensions described previously herein will have comparable cross-sectional dimensions (i.e., thicknesses or diameters). For example an SMA introducer with the same or substantially similar cross-sectional area as the previously described sensors can exhibit a one-time force of over 6 kg. That much force applied to an introducer having a pointed or sharpened tip 26, as shown in FIGS. 2A and 2B, would be more than sufficient to penetrate skin.

In addition to comparable sizes, the crosswise shape of introducer 20 may be identical or similar to that of sensor 10, such as illustrated in FIG. 2D, where both the introducer and sensor have a strip or flat rectangular configuration. Alternatively, the two components may each have a crescent or C-shape to facilitate their "nesting" engagement. In other embodiments, the sensor and introducer may have different cross-sectional shapes, where the shapes have respective mating configurations to also facilitate "nesting" of the sensor with the introducer. For example, the introducer may have a concave surface which engages with a corresponding convex surface of the sensor. Their respective outer or non-contacting surfaces may both be convex to facilitate penetration into the skin. Still yet, in certain embodiments, the crosswise configuration and size of introducer 20 may be substantially different from that of sensor 10. For example, the introducer may have a wire configuration with a relatively small cross-sectional surface area as compared to that of the sensor, provided the mass of the wire introducer is sufficient to conform the sensor into the predefined operative states.

It is noted that due to the metallic and, thus, conductive nature of introducer 20, care should be taken to ensure that the electrodes of sensor 10 (in electrochemical embodiments) are insulated from introducer 20. This may be accomplished by providing an insulative coating around either or both sensor 10 and introducer 20, while ensuring that such a coating does not in any way obstruct exposure of the sensing portion of the sensor electrodes to the subcutaneous environment.

In certain embodiments, introducer 20 is configured at its proximal end 24 to couple, mate or engage with an activa-

tion mechanism or component 28 (illustrated schematically) for activating a transition from the first operative state of FIG. 2A to the second operative state of FIG. 2B. The construct and the type of energy/force imparted by activation component 28 is dependent upon the type of memory function employed by introducer 20. For introducers 20 having a heat-transitionable memory, activation component 28 may be an electrical coupling to a source of electrical power for conducting an electrical current to introducer 20 which heats the introducer SMA material to a temperature sufficient to transition the introducer from its heat-unstable martensitic state (i.e., the first operative state of FIG. 2A) to its heat-stable austenitic state (i.e., the second operative state of FIG. 2B). For introducers 20 having an elastic memory, activation component 28 may include a mechanical coupling between introducer 20 and a driving mechanism for imparting a physical force on introducer 20 sufficient to translate it out from a physically confining space, such as within a housing of an on-skin unit as illustrated in FIGS. 3A and 3B, in order to transition the introducer from its loaded, stressed configuration (i.e., the first operative state of FIG. 3A) to its unloaded, unstressed configuration (i.e., the second operative state of FIG. 3B).

Referring now to FIGS. 3A and 3B, there is shown an analyte monitoring system 30 in which operatively assembled sensor 10 (see FIG. 2A) and introducer 20 are shown operatively coupled to a sensor control unit 34 contained within an on-skin/on-body housing 32. Control unit 34 may provide most or all of the electronic components of an analyte monitoring system including, but not limited to, data processing and communication electronics, the latter of which may include a transmitter for relaying or providing data obtained using the sensor to a remotely located device. The control unit 34 may also include a variety of optional components, such as, for example, a receiver, a power supply (e.g., a battery), an alarm system, a display, a user input mechanism, a data storage unit, a watchdog circuit, a clock, a calibration circuit, etc. A remote unit (not shown), if employed with the on-skin control unit 34, may include one or more of the same components and/or additional components such as an analyte measurement circuit for use with a test strip sensor, a pager, a telephone interface, a computer interface, etc. Examples of such are provided in the patents and patent applications incorporated by reference above.

Housing 32 preferably has a low-profile configuration to provide comfort to the patient or user and enable easy concealment. Housing 32 may include a base or mounting structure 36 which is configured for releasable engagement with the skin surface 45, such as by an adhesive layer, patch or strip 38, or by strapping it to the body. Housing 32 is further configured to provide or facilitate physical and/or electrical coupling between the proximal portion of sensor 10 (not shown in FIGS. 3A and 3B) and control unit 34, as well as to electrically and/or mechanically couple proximal portion of introducer 20 to an activation component 28 (see FIGS. 2A and 2B; not shown in FIGS. 3A and 3B). The respective distal portions 12, 22 of sensor 10 and introducer 20 extend from control unit 34 to within a chamber or compartment 44 within housing 32. An aperture 40 is provided within mounting structure 36 and adhesive layer 38 to allow for the extension therethrough of engaged and nested sensor and introducer distal portions 12, 22 when introducer 20 is caused to transition from the first operative or contained state of FIG. 3A to the second operative or extended or implanted state of FIG. 3B by the introducer's SMA memory function.

The introducer transition activation component 28, as discussed above, may be an electrical and/or mechanical component depending on the type of memory function employed by the particular introducer 20, and may be physically housed within or coupled to or associated with housing 32 and/or control unit 34.

For introducer embodiments having heat-transitionable memory capabilities, the proximal end 24 of introducer 20 is coupled to an electrical activation component. In certain of these embodiments, the activation component is an electrical power source, e.g., a battery or power circuit, and/or the associated electrical coupling housed within housing 32 and/or control unit 34. System 30 may be configured such that when control unit 34 is turned on, subsequent to operative mounting of the on-skin unit, an electrical current is provided from the battery or power circuit to introducer 20 by electrical coupling between the two. Such electrical coupling may be a wire or an electrical contact extending between the proximal portion 24 of introducer 20 and the power source, or proximal portion 24 may be directly electrically coupled to the power source. The amount of current supplied to introducer 20 is sufficient to result in a temperature rise sufficient to trigger the martensitic-to-austenitic shape change, which physical change in introducer 20 causes it, along with nested/coupled sensor 10, to be forced downward through housing aperture 40 and through the adjacent skin surface 45 (see FIG. 3B). The activation/transition temperature should have a minimum value sufficiently greater than the range of possible ambient temperatures to avoid unintentional activation of the introducer's shape change, but otherwise should have a maximum value as low as possible to minimize the amount of energy required to activate it. In certain embodiments, the activation temperature of SMA introducer 20 is just below body temperature (37° C.) so that activation and transcutaneous insertion occurs automatically very shortly after the on-body control unit housing 32 is attached to the skin. The maximum heat generated in the introducer should not exceed a temperature which may feel uncomfortable to the user, cause burning of or damage to the user's skin or tissue, or cause damage to the medical device, such as sensor 10, to which the introducer is engaged.

The electrical current necessary to activate a heat-transitionable SMA introducer of the present disclosure will vary depending on the size, i.e., cross-sectional dimension, of the introducer. More specifically, the minimum required current (I_{M-A}) to produce or activate the requisite temperature to initiate the martensitic-to-austenitic transition of SMA structures is generally represented by the linear equation

$$I_{M-A} \text{ (amps)} = 0.25 \times 10^{-4} \text{ (amps}/\mu\text{m}^2) \times A \text{ } (\mu\text{m}^2),$$

where A is the average cross-sectional area of the SMA structure. Accordingly, for introducers having sizes suitable for implantation of the sensors described above, i.e., having cross-sectional areas in the range from about 400 μm^2 to about 1,440 $\times 10^3 \mu\text{m}^2$, and more typically from about 40 $\times 10^3 \mu\text{m}^2$ to about 360 $\times 10^3 \mu\text{m}^2$, the activation current will range from about 0.01 amps to about 36 amps, and more typically from about 1 amp to about 9 amps, but may be higher or lower depending on the size of the introducer. In one particular embodiment in which the sensor distal section has a rectangular cross-section with a thickness of about 200 μm , a width of about 600 μm , and a resulting cross-sectional area of about 120 $\times 10^3 \mu\text{m}^2$, and the corresponding SMA introducer has substantially similar dimensions, the activation current range is about 3 amps.

Typically, the activation current need only be supplied to the introducer for less than a second (i.e., milliseconds) to create the shape transition in the introducer and to drive the sensor into the skin. When the temperature of the SMA introducer reaches a temperature above ambient temperature, it begins to cool spontaneously through free convection. For efficiency and power conservation reasons, then, it is advantageous to heat the introducer to its transition temperature as quickly as possible. The larger the control unit battery, the greater the possible output current and the faster the introducer is heated. However, to avoid adding unwanted weight and mass to the on-body control unit with a larger battery, a super capacitor may be placed in a parallel circuit with a smaller battery to insulate the battery from the high power draw of the SMA introducer. Alternatively, a separate hand-held battery pack may be provided which is used only initially upon operative placement of the on-body control unit to activate the SMA introducer. After transcutaneous insertion of the sensor, the battery pack may be unplugged from the control unit and the on-board, internally housed smaller battery employed to operate the device.

In certain embodiments, introducer 20 may include an insulative layer to protect the patient or user and/or the medical device, such as sensor 10, from heat or electrical damage due to the current and subsequent temperature increase provided to introducer 20 to transition from the first operative state to the second operative state.

Pursuant to certain introducer embodiments providing an elastic memory function, proximal end 24 of introducer 20 is coupled to a mechanical activation component (not illustrated). When activated, the mechanism axially drives or moves introducer 20 such that it is caused to forcibly abut the side and/or overhead interior walls 42 of compartment 44 (see FIG. 3A) which, in turn, forces at least distal portion 22 of introducer 20 and nested sensor 10 through housing aperture 40. Alternatively, compartment 44 may have a construct different than the one illustrated, and a mechanical driving force other than an axial force may be placed upon introducer 20 in order to initiate the displacement of it through aperture 40. In either case, the mechanical activation component may be activated automatically upon turning on control unit 34 or may be triggered manually by a switch or button (not shown) provided on the outer surface of housing 32. Upon release from the confinement of compartment 44, the loaded introducer structure 20 reverts to its unstressed, unconfined original state which drives it into the skin surface 45 (see FIG. 3B).

With any of the above described embodiments, system 30 may be configured such that introducer 20 is automatically retracted or removed from the skin 45 immediately upon transcutaneous placement of sensor 10 while leaving sensor 10 transcutaneously implanted. In the heat-transitionable memory embodiments of introducer 20, cessation of the current supply to introducer 20 initiates a cooling of introducer 20 to a temperature which commences the shape conversion from the second operative state, i.e., the heat-stable austenitic state, to the first operative state, i.e., the heat-unstable martensitic state, thereby removing itself from the skin and back into compartment 44. In certain embodiments, the cooling process may be expedited to transition introducer 20 from the second operative state back to the first operative state. Because the transcutaneous application and the subcutaneous environment in which introducer 20 is employed, the temperature ranges in which the introducer changes shape, in certain embodiments, will be relatively narrow, e.g., from about 45° C. (for introducer removal) to about 65° C. (for introducer insertion), but may have a

narrow or wider temperature range. In the elastic memory introducer embodiments, removal of the introducer may be effected mechanically (not shown), e.g., by utilizing an extension spring or the like, which pulls or lifts introducer 20 in a retrograde direction, i.e., in a direction opposite to its entry into the skin, thereby retrieving the distal portion 22 extending from aperture 40 back into compartment 44. Such a mechanical removal approach may also be used for heat-transitionable introducer embodiments in lieu of having to electrically reactivate the introducer and, in certain embodiments, reconnect the ancillary battery pack.

Alternatively, with introducers of either type of memory function, system 30 may be configured such that introducer 20 remains implanted with sensor 10 for the useful life of the sensor, and is removed along with the sensor upon sensor expiration. While a heat-transitionable SMA introducer may be configured to remove itself as well as the sensor from the implant site, i.e., to transition it from the second operative or austenitic shape back to the first operative or martensitic shape, it may be more efficient and less complicated and costly to simply employ a mechanical retraction component to retract the coupled introducer and sensor back into compartment 44 of housing 32. The same mechanical activation component used for transitioning an elastic memory introducer to a transcutaneously implanted condition may be used to reversibly transition the introducer whereby it is retracted from the skin back into compartment 44. Still yet, systems employing either type of SMA introducer may be configured such that the coupled introducer and sensor are merely pulled out of the skin insertion site along with manual removal of housing 32 from the skin.

Referring now to FIGS. 4A and 4B and FIGS. 5A and 5B, two other sensors 50 and 60 of the present disclosure are provided which are configured to include a feature or structure which enables the respective sensor to be completely self-implanting, i.e., advanced from an on-skin housing/unit to a desired transcutaneous position without the use of a separate introducer, such as introducer 20. Referring to the Figures, in certain embodiments, a member 54 or members 64 made of a shape-shifting material, such as nitinol (NiTi) or another SMA, are provided along at least a portion of the length of the respective sensor substrates 52 and 62, the latter being made of one or more flexible materials discussed above with respect to sensor 10. As such, the respective members 54, 64 function as "spines" to facilitate translation or movement of sensors 50, 60 and, along with pointed substrate tips 56, 66, facilitate penetration of sensors 50, 60 through the skin surface. With sensor 50, for example, a single SMA spine 54 extends substantially along the central axis on one side of sensor 50. With sensor 60, two parallel, spaced apart spines 64 extend along opposing sides of sensor 60. However, any suitable number and location of the spines may be employed on a particular sensor.

The SMA spine(s) may have the heat-transitionable and/or elastic memory characteristics discussed above with respect to introducer 20 and, as such, enable sensors 50, 60 to itself take on the first and second operative states discussed above with respect to introducer 20 but without the assistance of an introducer. In heat-transitionable memory sensor embodiments, spines 54, 64 are electrically coupled to a source of electrical power in a manner similar to that described above with respect to introducer 20, with the coupling to the power source being, in certain embodiments, for example, directly through the control unit of the system. However, the temperature for converting sensors 50, 60 back to the first operative state in order to effect retraction from skin, is likely to be below body temperature, otherwise, the

sensors will not remain implanted, but immediately or imminently retract themselves upon cessation of current to their respective spines 54, 64. In elastic memory sensor embodiments, spines 54, 64 are coupled to a mechanical driving mechanism at proximal ends in a manner similar to that described above with respect to introducer 20, with transcutaneous implantation and retraction of sensor 50 being similar as well.

Because of the metallic nature of SMA materials, spines 54, 64 may double as functional electrodes of their respective sensors 50, 60 in the electrochemical sensing of an analyte. In heat-transitional embodiments of such aspects of the present disclosure, spines 54, 64 would function to first translate or drive sensors 50, 60 transcutaneously into the skin and, upon cessation of the driving electrical current through it, would function as analyte sensing electrodes, e.g., as either a working, reference and/or counter electrode.

As shown in the cross-sectional view of FIG. 4B, spine 54 may be embedded within a surface of substrate 52 so as to provide sensor 50 with a flush exterior. Alternatively, spine 54 may lie on a surface of substrate 52 or, as shown in FIG. 5B, spine 64 may form one or more portions or sides of the overall sensor construct. The substrate surface on which or within which the spines is/are provided may be a major surface, as in FIG. 4B, i.e., extending the width side of the sensor substrate, or may be a minor surface, as in FIG. 5B, i.e., extending across the thickness of the sensor substrate. The respective spines 54, 64 extend from a proximal end of sensor 50, 60 (not shown) to a distal portion to the extent necessary to provide the necessary leverage (by mass and/or force) to operatively translate sensors 50, 60.

Sensors 50 and 60 may be fabricated by one or more extrusion methods. For example, the sensor substrate material 52, 62 may be made of a polymer material which may be formed in the desired shape by an extrusion process, in which case, the sensing components, including the conductive materials, as well as the SMA spines 54, 56 are formed or provided on the substrate material after extrusion. In still other embodiments, the subject sensors may be fabricated by an extrusion process in which the SMA spines and the non-conductive materials, e.g., dielectric material forming the substrate, are co-extruded. The substrate-spine structures may then be treated to provide the desired memory characteristics, either temperature-based or elastic types, to the SMA material of the spines. Subsequently, the remaining conductive materials, e.g., metal material forming the electrode and traces, are then formed thereon. Still yet, all of the conductive and non-conductive materials and components may be formed in a single extrusion process. Examples of sensors fabricated by extrusion methods are disclosed in U.S. Patent Application Publication Nos. 2010/0331728; 2010/0331771; 2010/0326842; 2010/0326843; and 2010/0331643; all of which are assigned to the assignee of the present disclosure and are incorporated herein by reference in their entireties.

Certain embodiments of the present disclosure may include system for transcutaneously implanting a medical device, the system comprising an introducer having at least a portion engageable with at least a portion of a medical device, wherein the introducer is at least partially formed from a shape memory material, and an activating component to activate the introducer to transition from a first operative shape memory state to a second operative shape memory state, wherein said transition translates the medical device engaged with the introducer from a position above the skin surface to at least partially through the skin surface.

In certain aspects, the first operative shape memory state may comprise a heat-unstable shape and the second operative shape memory state comprises a heat-stable shape.

In further aspects, the activating component may comprise an electrical current generating component electrically coupled to the introducer.

In certain aspects, the first operative shape memory state may comprise a loaded configuration and the second operative shape memory state comprises an unloaded configuration.

In certain aspects, the activating component may comprise a driving mechanism mechanically coupled to the introducer.

Certain aspects may further comprise a housing configured for placement on a skin surface of a host, wherein the introducer is configured to be at least partially positioned within the housing when in the first operative shape memory state.

In certain aspects, the housing may comprise a compartment within which the introducer is configured to be at least partially contained when in the first operative shape memory state.

In certain aspects, the shape memory material may comprise one or more of nickel-titanium, copper-zinc-aluminum-nickel, copper-aluminum-nickel, and alloys of zinc, copper, gold and iron.

In certain aspects, the portion of the introducer engageable with the medical device may define a major axis wherein, during the transition from the first operative shape memory state to the second operative shape memory state, the introducer changes shapes along the major axis.

In certain aspects, the medical device may comprise an in vivo sensor.

In certain aspects, the introducer may comprise at least one coupling member for securing the medical device to the introducer at least when in the first operative memory state.

Certain embodiments of the present disclosure may include a system for transcutaneously implanting a medical device, the system comprising a housing configured for placement on a skin surface of a host, an introducer configured to be at least partially positioned within the housing and having at least a portion engageable with at least a portion of a medical device, wherein the introducer is at least partially formed from a shape memory material, and an electrical current generating component electrically coupled to the introducer for activating the introducer to transition from a heat-unstable shape to a heat-stable shape, wherein said transition translates the medical device engaged with the introducer from a position within the housing to at least partially through the skin surface.

In certain aspects, the electrical current generating component may comprise a battery contained within the housing.

In certain aspects, the battery may be further configured to power a control unit for operating the medical device.

In certain aspects, the electrical current generating component may comprise a battery not contained within the housing.

Certain embodiments of the present disclosure may include a system for transcutaneously implanting a medical device, the system comprising a housing configured for placement on a skin surface of a host, an introducer configured to be at least partially positioned within the housing and having at least a portion engageable with at least a portion of a medical device, wherein the introducer is at least partially formed from a shape memory material, and a driving mechanism mechanically coupled to the introducer

for moving the introducer relative to the housing to transition the introducer from a loaded configuration to an unloaded configuration, wherein said transition translates the medical device engaged with the introducer from a position within the housing to at least partially through the skin surface.

In certain aspects, the housing may comprise a compartment configured to physically retain the introducer in the loaded configuration.

Certain embodiments of the present disclosure may include an in vivo analyte monitoring system comprising a housing configured for placement on a skin surface of a host, a control unit housed within the housing, an in vivo analyte sensor having a proximal portion and a distal portion, wherein the proximal portion is operatively coupleable to the control unit, a sensor introducer at least partially positioned within the housing, wherein the introducer is at least partially comprised of a shape memory material and wherein a portion of the introducer is engageable with the sensor distal portion, and a transitioning component to transition the introducer from a first operative shape memory state to a second operative shape memory state, wherein said transitioning translates the sensor distal portion from a position within the housing to at least partially through the skin surface.

In certain aspects, the portion of the introducer engageable with the sensor distal portion may have a crosswise dimension substantially similar to that of the sensor distal portion.

In certain aspects, the portion of the introducer engageable with the sensor distal portion may have a crosswise dimension smaller than that of the sensor distal portion.

In certain aspects, the sensor distal portion and the portion of the introducer engageable with the sensor distal portion may have respective configurations which enable a nesting arrangement between them.

In certain aspects, the portion of the introducer engageable with the sensor distal portion may comprise a U-shaped configuration when in the first operative shape memory state.

In certain aspects, the introducer may comprise a distal tip configured to substantially atraumatically pierce the skin surface.

In certain aspects, the introducer may comprise at least one coupling member for securing the sensor distal portion to the introducer at least when the introducer is in the first operative memory state.

Certain embodiments of the present disclosure may include a transcutaneously implantable medical device comprising a flexible, elongated substrate having a distal tip configured to substantially atraumatically pierce the skin surface, wherein the substrate is formed from a non-conductive material, and at least one spine extending along a length of the substrate, wherein the at least one spine is formed from a shape memory material, and wherein the medical device is translatable from a first operative shape memory state to a second operative shape memory state.

In certain aspects, the first operative shape memory state may comprise a heat-unstable shape and the second operative shape memory state comprises a heat-stable shape.

In certain aspects, the first operative shape memory state may comprise a compressed configuration and the second operative shape memory state comprises an uncompressed configuration.

In certain aspects, the shape memory material may comprise one or more of nickel-titanium, copper-zinc-aluminum-nickel, copper-aluminum-nickel, and alloys of zinc, copper, gold and iron.

In certain aspects, the medical device may be an electrochemical sensor.

In certain aspects, the electrochemical sensor may comprise at least one electrode.

In certain aspects, at least one spine may function as the at least one electrode.

In certain aspects, the electrochemical sensor may be an analyte sensor.

In certain aspects, the analyte sensor may be a glucose sensor.

Certain embodiments of the present disclosure may include a method for transcutaneously implanting a medical device, at least a portion of which is flexible, the method comprising providing an introducer, wherein the introducer is at least partially formed from a shape memory material, engaging at least the flexible portion of the medical device with the introducer, wherein the engaged introducer and medical device are in a nested arrangement, and wherein the introducer is in a first operative shape memory state, positioning a skin-penetrating end of the introducer adjacent the skin surface, and transitioning the introducer from the first operative shape memory state to a second operative shape memory state, wherein the introducer penetrates through the skin surface and transcutaneously implants the flexible portion of the medical device.

In certain aspects, engaging the flexible portion of the medical device with the introducer in a nested arrangement may comprise cooling the introducer to a predefined temperature while the medical device is structurally aligned along a major axis of the introducer.

In certain aspects, transitioning the introducer from the first operative shape memory state to the second operative shape memory state may comprise applying a selected amount of electrical current to the introducer.

In certain aspects, engaging the flexible portion of the medical device with the introducer in a nested arrangement may comprise loading the introducer to a reduced profile while the medical device is structurally aligned along a major axis of the introducer and positioning the introducer and nested sensor in a confined space.

In certain aspects, transitioning the introducer from the first operative shape memory state to the second operative shape memory state may comprise releasing the introducer from the confined space.

In certain aspects, the confined space may be provided within a housing that is configured for placement on the skin surface.

Certain aspects may further comprise removing the introducer from the skin while leaving the medical device transcutaneously implanted.

In certain aspects, the removing the introducer from the skin while leaving the medical device transcutaneously implanted may comprise manually retracting the introducer from within the skin.

Certain aspects may further comprise maintaining the introducer within the skin along with the transcutaneously implanted medical device for the useful life of the medical device.

Certain aspects may further comprise simultaneously removing the introducer and the medical device from the skin subsequent to the expiration of the useful life of the medical device.

In certain aspects, the simultaneous removal of the introducer and the medical device from the skin may comprise manually retracting the introducer and the medical device.

In certain aspects, the simultaneous removal of the introducer and the medical device from the skin may comprise transitioning the introducer from the second operative shape memory state to the first operative shape memory state.

In certain aspects, the medical device may comprise an analyte sensor.

The preceding merely illustrates the principles of the disclosure. It will be appreciated that those skilled in the art will be able to devise various arrangements which, although not explicitly described or shown herein, embody the principles of the disclosure and are included within its spirit and scope. Furthermore, all examples and conditional language recited herein are principally intended to aid the reader in understanding the principles of the disclosure and the concepts contributed by the inventors to furthering the art, and are to be construed as being without limitation to such specifically recited examples and conditions. Moreover, all statements herein reciting principles, aspects, and embodiments of the disclosure as well as specific examples thereof, are intended to encompass both structural and functional equivalents thereof. Additionally, it is intended that such equivalents include both currently known equivalents and equivalents developed in the future, i.e., any elements developed that perform the same function, regardless of structure. The scope of the present disclosure, therefore, is not intended to be limited to the exemplary embodiments shown and described herein. Rather, the scope and spirit of present disclosure is embodied by the appended claims.

What is claimed is:

1. A system for transcutaneously implanting a medical device, the system comprising:

an introducer having at least a portion engageable with at least a portion of a medical device, wherein the introducer comprises a shape memory alloy having a predetermined activation temperature range, wherein the introducer, at a temperature below the predetermined activation temperature range, is in a first shape memory state configuration in which the introducer includes a first transition bend adjacent to a straight proximal portion of the introducer, and wherein the introducer, at a temperature above the predetermined activation temperature range, is in a second shape memory state configuration in which the introducer includes a second transition bend adjacent to a straight distal portion of the introducer; and

an activating component to change the temperature of the introducer to transition the introducer from the first shape memory state configuration to the second shape memory state configuration, wherein said transition changes the shape of the introducer and translates the medical device engaged with the introducer from a position above the skin surface to a position at least partially through the skin surface; wherein said transition is driven by a martensitic-to-austenitic change of the shape memory alloy.

2. The system of claim 1 wherein the activating component comprises an electrical current generating component electrically coupled to the introducer to heat the introducer above the predetermined activation temperature range to cause the transition of the introducer from the first shape memory state configuration to the second shape memory state configuration.

3. The system of claim 1 further comprising a housing configured for releasable placement on a skin surface of a host using an adhesive, wherein the introducer is configured to be at least partially positioned within the housing when in the first shape memory state configuration.

4. The system of claim 3 wherein the housing comprises a compartment within which the introducer is configured to be at least partially contained when in the first shape memory state configuration.

5. The system of claim 1 wherein the shape memory alloy comprises one or more of nickel-titanium, copper-zinc-aluminum-nickel, copper-aluminum-nickel, and alloys of zinc, copper, gold and iron.

6. The system of claim 1 wherein the medical device is an analyte sensor and further wherein the portion of the introducer engageable with the medical device defines a major axis wherein, during the transition from the first shape memory state configuration to the second shape memory state configuration, a distal portion of the introducer changes shape along the major axis, while a proximal portion of the introducer remains fixed relative to the activating component.

7. The system of claim 1 wherein the introducer comprises at least one coupling member for securing the medical device to the introducer at least when in the first shape memory state configuration.

8. The system of claim 1 wherein the introducer, in the first shape memory state configuration, comprises a U-shaped distal portion that transitions at a bend to a straight proximal portion, and wherein the introducer, in the second shape memory state configuration, is L-shaped.

9. The system of claim 1, wherein the introducer includes an insulative layer to protect the user or medical device from heat or electrical damage.

10. The system of claim 1, wherein the location of the first transition bend along the length of the introducer differs from the location of the second transition bend.

11. The system of claim 1, wherein the location of the first transition bend along the length of the introducer coincides with the location of the second transition bend.

12. A method for transcutaneously implanting a medical device, at least a portion of which is flexible, the method comprising:

engaging at least the flexible portion of the medical device with an introducer, wherein the engaged introducer and medical device are in a nested arrangement, and wherein the introducer comprises a shape memory alloy having a predetermined activation temperature range,

wherein the introducer, at a temperature below the predetermined activation temperature range is in a first shape memory state configuration in which the introducer includes a first transition bend adjacent to a straight proximal portion of the introducer, and wherein the introducer, at a temperature above the predetermined activation temperature range is in a second shape memory state configuration in which the introducer includes a second transition bend adjacent to a straight distal portion of the introducer; and

positioning a skin-penetrating end of the introducer adjacent the skin surface; and

changing the temperature of the introducer to transition the introducer from the first shape memory state configuration to the second shape memory state configuration such that the introducer penetrates through the skin surface and transcutaneously implants the flexible

23

portion of the medical device, and further wherein said transition changes the shape of the introducer, and is driven by a martensitic-to-austenitic change of the shape memory alloy.

13. The method of claim 12 wherein engaging the flexible portion of the medical device with the introducer in a nested arrangement comprises cooling the introducer below the predetermined activation temperature range while the medical device is structurally aligned along a major axis of the introducer, and wherein a distal portion of the introducer changes shape along the major axis, while a proximal portion of the introducer remains fixed relative to the activating component.

14. The method of claim 13 wherein transitioning the introducer from the first shape memory state configuration to the second shape memory state configuration comprises applying a selected amount of electrical current from an electrical current generating component electrically coupled to the introducer to heat the introducer above the predetermined activation temperature range.

15. The method of claim 12 further comprising removing the introducer from the skin while leaving the medical device transcutaneously implanted.

24

16. The method of claim 12 further comprising maintaining the introducer within the skin along with the transcutaneously implanted medical device for the useful life of the medical device.

17. The method of claim 16 further comprising simultaneously removing the introducer and the medical device from the skin subsequent to the expiration of the useful life of the medical device.

18. The method of claim 17 wherein the simultaneous removal of the introducer and the medical device from the skin comprises transitioning the introducer from the second shape memory state configuration to the first shape memory state configuration.

19. The method of claim 12 wherein the introducer, in the first shape memory state configuration, comprises a U-shaped distal portion that transitions at a bend to a straight proximal portion, and wherein the introducer, in the second shape memory state configuration, is L-shaped.

20. The method of claim 12, wherein the introducer includes an insulative layer to protect the user or medical device from heat or electrical damage.

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专利名称(译)	用于经皮植入医疗装置的系统和方法		
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摘要(译)

提供了用于经皮植入医疗装置的系统和方法，例如体内分析物传感器。该系统和方法涉及使用由形状记忆合金 (SMA) 材料制成的引入器或插入器，其可从一个操作状态或配置转换到另一个操作状态或配置，其中从状态到状态的转换使得经皮植入和/或经皮外植医疗器械。

